

# **SSD1308**

## ***Advance Information***

**128 x 64 Dot Matrix  
OLED/PLED Segment/Common Driver with Controller**

This document contains information on a new product. Specifications and information herein are subject to change without notice.

#### **Appendix: IC Revision history of SSD1308 Specification**

<b>Version</b>	<b>Change Items</b>	<b>Effective Date</b>
0.10	1 <sup>st</sup> Release	30-May-08
1.0	<ol style="list-style-type: none"><li>1. Changed to Advance Information</li><li>2. Update die thickness tolerance from <math>\pm 25\mu m</math> to <math>\pm 15\mu m</math></li><li>3. Round <math>I_{REF}</math> to 19uA from 18.75uA</li><li>4. Update Table 11-1 and Table 12-1</li></ol>	27-Oct-08

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## 1 GENERAL DESCRIPTION

SSD1308 is a single-chip CMOS OLED/PLED driver with controller for organic / polymer light emitting diode dot-matrix graphic display system. It consists of 128 segments and 64 commons. This IC is designed for Common Cathode type OLED panel.

The SSD1308 embeds with contrast control, display RAM and oscillator, which reduces the number of external components and power consumption. It has 256-step brightness control. Data/Commands are sent from general MCU through the hardware selectable 6800/8080 series compatible Parallel Interface, I<sup>2</sup>C interface or Serial Peripheral Interface. It is suitable for many compact portable applications, such as mobile phone sub-display, MP3 player and calculator, etc.

## 2 FEATURES

- Resolution: 128 x 64 dot matrix panel
- Power supply
  - V<sub>DD</sub> = 1.65V to 3.3V for IC logic
  - V<sub>CC</sub> = 7V to 15V for Panel driving
- For matrix display
  - OLED driving output voltage, 15V maximum
  - Segment maximum source current: 150uA
  - Common maximum sink current: 20mA
- 256 step contrast brightness current control
- Internal / External I<sub>REF</sub> Selection
- Embedded 128 x 64 bit SRAM display buffer
- Pin selectable MCU Interfaces:
  - 8-bit 6800/8080-series parallel interface
  - 3 / 4 wire Serial Peripheral Interface
  - I<sup>2</sup>C Interface
- Screen saving continuous scrolling function in both horizontal and vertical direction
- RAM write synchronization signal
- Programmable Frame Rate and Multiplexing Ratio
- Row Re-mapping and Column Re-mapping
- On-Chip Oscillator
- Chip layout for COG & COF
- Wide range of operating temperature: -40°C to 85°C

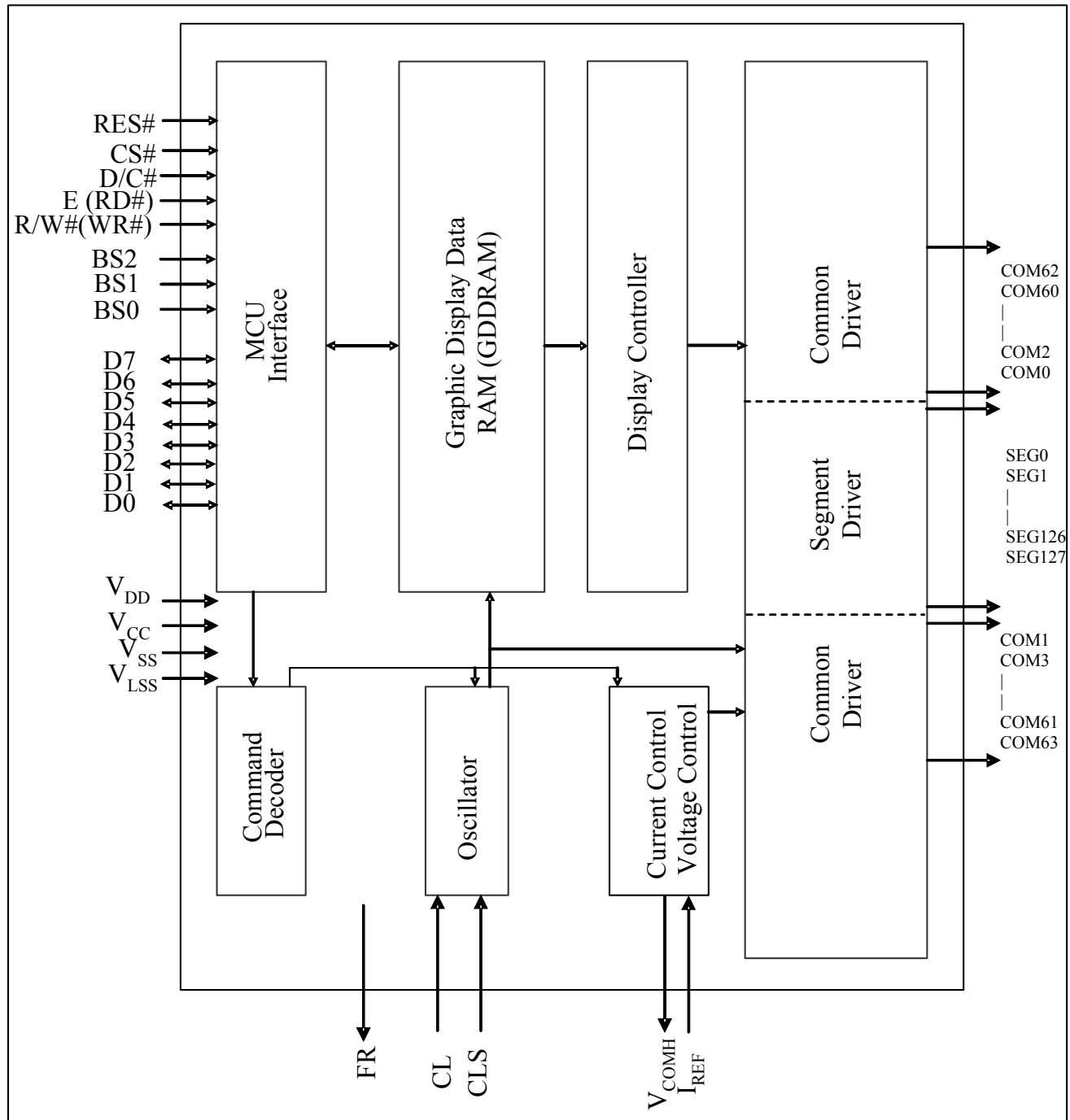
## 3 ORDERING INFORMATION

Table 3-1: Ordering Information

Ordering Part Number	SEG	COM	Package Form	Reference	Remark
SSD1308Z	128	64	COG	9, 55	<ul style="list-style-type: none"><li>◦ Min SEG pad pitch : 47um</li><li>◦ Min COM pad pitch : 40um</li><li>◦ Die thickness: 300 +/- 15um</li></ul>

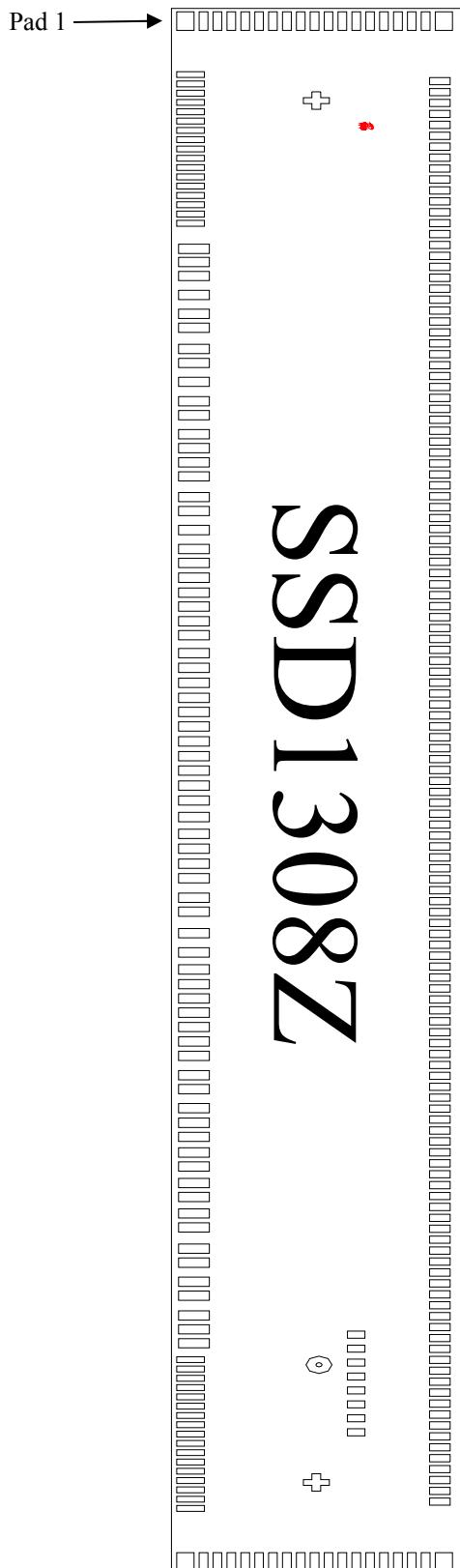
## 4 BLOCK DIAGRAM

Figure 4-1 SSD1308 Block Diagram



## 5 DIE PAD FLOOR PLAN

Figure 5-1 : SSD1308Z Die Drawing



Die size	6.76mm x 0.86mm
Die thickness	300 +/- 15um
Min I/O pad pitch	60um
Min SEG pad pitch	47um
Min COM pad pitch	40um
Bump height	Nominal 15um

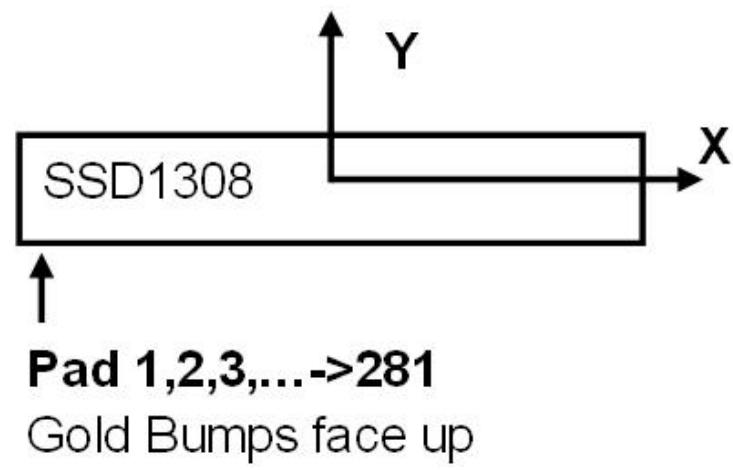
Bump size	
Pad 1, 106, 124, 256	80um x 50um
Pad 2-18, 89-105, 107-123, 257-273	25um x 80um
Pad 19-88	40um x 89um
Pad 125-255	31um x 59um
Pad 274-281 (TR pads)	30um x 50um

Alignment mark	Position	Size
+ shape	(-2973, 0)	75um x 75um
+ shape	(2973, 0)	75um x 75um
Circle	(2466.665, 7.575)	R37.5um, inner 18um
SSL Logo	(-2862.35, 144.82)	-

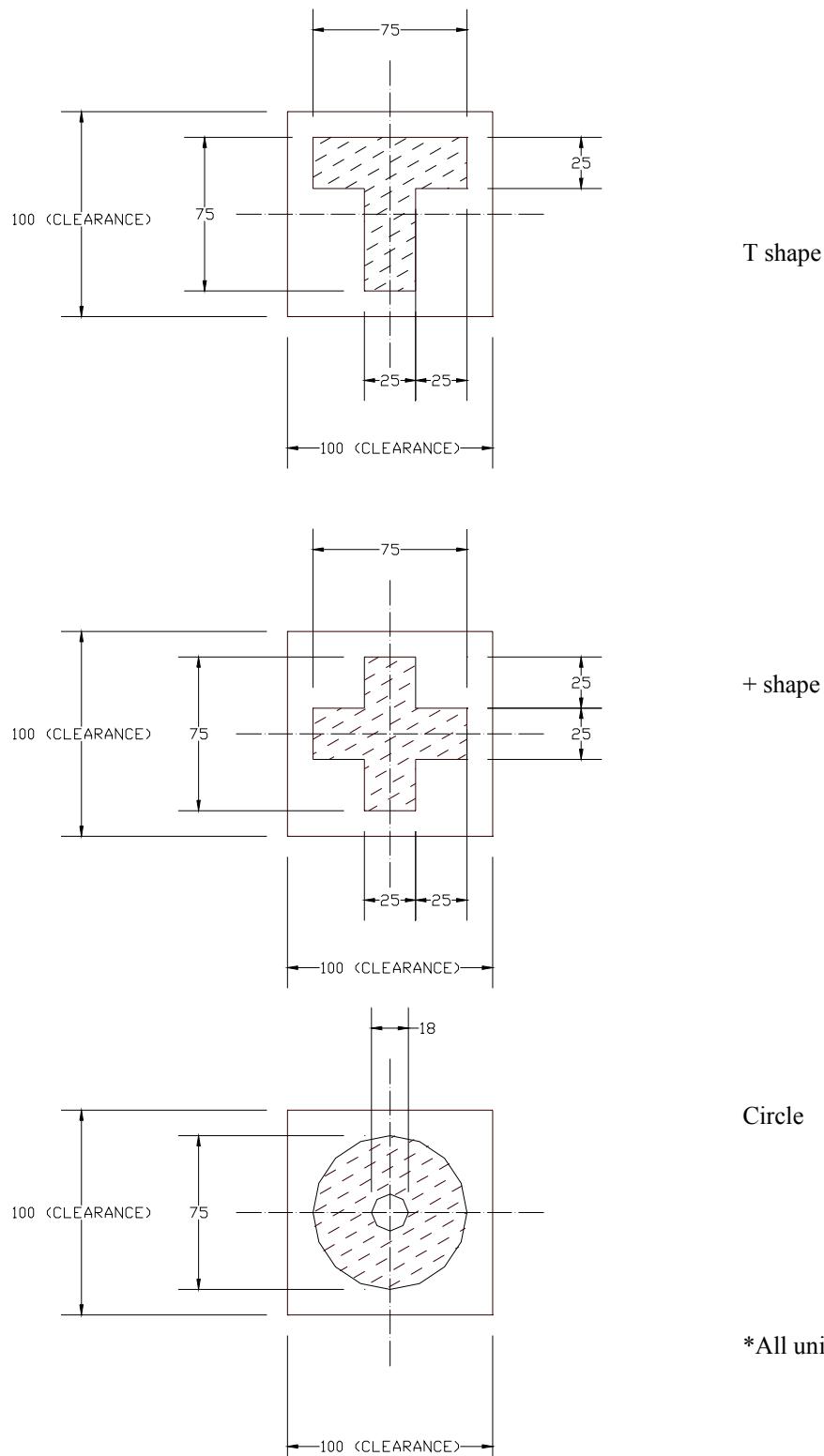
(For details dimension please see p.10 )

### Note

- <sup>(1)</sup> Diagram showing the Gold bumps face up.
- <sup>(2)</sup> Coordinates are referenced to center of the chip.
- <sup>(3)</sup> Coordinate units and size of all alignment marks are in um.
- <sup>(4)</sup> All alignment keys do not contain gold



**Figure 5-2 : SSD1308Z alignment mark dimensions**



**Table 5-1 : SSD1308Z Bump Die Pad Coordinates**

Pad no.	Pad Name	X-pos	Y-pos	Pad no.	Pad Name	X-pos	Y-pos	Pad no.	Pad Name	X-pos	Y-pos
1	NC	-331.5	-377.5	81	VCOMH	1875.585	-352.83	161	SEG35	1364.5	356
2	VSS	-3084.77	-362.5	82	VCC	1967.185	-352.83	162	SEG36	1317.5	356
3	COM49	-3044.77	-362.5	83	VCC	2027.185	-352.83	163	SEG37	1270.5	356
4	COM50	-3004.77	-362.5	84	VLSS	2109.185	-352.83	164	SEG38	1223.5	356
5	COM51	-2964.77	-362.5	85	VLSS	2169.185	-352.83	165	SEG39	1176.5	356
6	COM52	-2924.77	-362.5	86	VLSS	2254.185	-352.83	166	SEG40	1129.5	356
7	COM53	-2884.77	-362.5	87	NC	2314.185	-352.83	167	SEG41	1082.5	356
8	COM54	-2844.77	-362.5	88	NC	2374.185	-352.83	168	SEG42	1035.5	356
9	COM55	-2804.77	-362.5	89	VSS	2444.77	-362.5	169	SEG43	988.5	356
10	COM56	-2764.77	-362.5	90	COM31	2484.77	-362.5	170	SEG44	941.5	356
11	COM57	-2724.77	-362.5	91	COM30	2524.77	-362.5	171	SEG45	894.5	356
12	COM58	-2684.77	-362.5	92	COM29	2564.77	-362.5	172	SEG46	847.5	356
13	COM59	-2644.77	-362.5	93	COM28	2604.77	-362.5	173	SEG47	800.5	356
14	COM60	-2604.77	-362.5	94	COM27	2644.77	-362.5	174	SEG48	753.5	356
15	COM61	-2564.77	-362.5	95	COM26	2684.77	-362.5	175	SEG49	706.5	356
16	COM62	-2524.77	-362.5	96	COM25	2724.77	-362.5	176	SEG50	659.5	356
17	COM63	-2484.77	-362.5	97	COM24	2764.77	-362.5	177	SEG51	612.5	356
18	VCOMH	-2444.77	-362.5	98	COM23	2804.77	-362.5	178	SEG52	565.5	356
19	NC	-2334.965	-352.83	99	COM22	2844.77	-362.5	179	SEG53	518.5	356
20	TR7	-2278.265	-352.83	100	COM21	2884.77	-362.5	180	SEG54	471.5	356
21	TR7	-2218.265	-352.83	101	COM20	2924.77	-362.5	181	SEG55	424.5	356
22	TR8	-2136.715	-352.83	102	COM19	2964.77	-362.5	182	SEG56	377.5	356
23	TR8	-2055.465	-352.83	103	COM18	3004.77	-362.5	183	SEG57	330.5	356
24	TR9	-1995.465	-352.83	104	COM17	3044.77	-362.5	184	SEG58	283.5	356
25	TR9	-1904.115	-352.83	105	VSS	3084.77	-362.5	185	SEG59	236.5	356
26	TR10	-1844.115	-352.83	106	NC	3315	-377.5	186	SEG60	189.5	356
27	TR10	-1762.865	-352.83	107	COM16	3315	-325	187	SEG61	142.5	356
28	VDD1	-1679.31	-352.83	108	COM15	3315	-285	188	SEG62	95.5	356
29	VDD1	-1619.31	-352.83	109	COM14	3315	-245	189	SEG63	48.5	356
30	TR11	-1537.51	-352.83	110	COM13	3315	-205	190	SEG64	1.5	356
31	BGND	-1477.51	-352.83	111	COM12	3315	-165	191	SEG65	-45.5	356
32	VCC	-1416.01	-352.83	112	COM11	3315	-125	192	SEG66	-92.5	356
33	VCC	-1356.01	-352.83	113	COM10	3315	-85	193	SEG67	-139.5	356
34	VCOMH	-1266.955	-352.83	114	COM9	3315	-45	194	SEG68	-186.5	356
35	VCOMH	-1206.955	-352.83	115	COM8	3315	-5	195	SEG69	-233.5	356
36	VLSS	-1125.155	-352.83	116	COM7	3315	35	196	SEG70	-280.5	356
37	VLSS	-1043.355	-352.83	117	COM6	3315	75	197	SEG71	-327.5	356
38	VLSS	-983.355	-352.83	118	COM5	3315	115	198	SEG72	-374.5	356
39	VSS	-920	-352.83	119	COM4	3315	155	199	SEG73	-421.5	356
40	VSS	-856	-352.83	120	COM3	3315	195	200	SEG74	-468.5	356
41	VSS	-796	-352.83	121	COM2	3315	235	201	SEG75	-515.5	356
42	VDD	-732.645	-352.83	122	COM1	3315	275	202	SEG76	-562.5	356
43	VDD	-672.645	-352.83	123	COM0	3315	315	203	SEG77	-609.5	356
44	BS0	-595.655	-352.83	124	NC	3315	367.5	204	SEG78	-656.5	356
45	VSS	-531.955	-352.83	125	NC	3055.5	356	205	SEG79	-703.5	356
46	BS1	-467.655	-352.83	126	SEG0	3009.5	356	206	SEG80	-750.5	356
47	VDD	-403.155	-352.83	127	SEG1	2962.5	356	207	SEG81	-797.5	356
48	VDD	-342.555	-352.83	128	SEG2	2915.5	356	208	SEG82	-844.5	356
49	BS2	-279.705	-352.83	129	SEG3	2868.5	356	209	SEG83	-891.5	356
50	VSS	-215.705	-352.83	130	SEG4	2821.5	356	210	NC	-940	356
51	FR	-151.955	-352.83	131	SEG5	2774.5	356	211	SEG84	-988.5	356
52	CL	-89.815	-352.83	132	SEG6	2727.5	356	212	SEG85	-1035.5	356
53	VSS	-25.665	-352.83	133	SEG7	2680.5	356	213	SEG86	-1082.5	356
54	CS#	38.635	-352.83	134	SEG8	2633.5	356	214	SEG87	-1129.5	356
55	RES#	109.835	-352.83	135	SEG9	2586.5	356	215	SEG88	-1176.5	356
56	D/C#	182.425	-352.83	136	SEG10	2539.5	356	216	SEG89	-1223.5	356
57	VSS	246.125	-352.83	137	SEG11	2492.5	356	217	SEG90	-1270.5	356
58	R/W#	310.425	-352.83	138	SEG12	2445.5	356	218	SEG91	-1317.5	356
59	E	373.125	-352.83	139	SEG13	2398.5	356	219	SEG92	-1364.5	356
60	VDD	457.175	-352.83	140	SEG14	2351.5	356	220	SEG93	-1411.5	356
61	VDD	517.175	-352.83	141	SEG15	2304.5	356	221	SEG94	-1458.5	356
62	D0	609.275	-352.83	142	SEG16	2257.5	356	222	SEG95	-1505.5	356
63	D1	692.475	-352.83	143	SEG17	2210.5	356	223	SEG96	-1552.5	356
64	D2	765.675	-352.83	144	SEG18	2163.5	356	224	SEG97	-1599.5	356
65	D3	828.875	-352.83	145	SEG19	2116.5	356	225	SEG98	-1646.5	356
66	VSS	890.325	-352.83	146	SEG20	2069.5	356	226	SEG99	-1693.5	356
67	D4	951.275	-352.83	147	SEG21	2022.5	356	227	SEG100	-1740.5	356
68	D5	1013.315	-352.83	148	SEG22	1975.5	356	228	SEG101	-1787.5	356
69	D6	1075.355	-352.83	149	SEG23	1928.5	356	229	SEG102	-1834.5	356
70	D7	1137.395	-352.83	150	SEG24	1881.5	356	230	SEG103	-1881.5	356
71	VSS	1220.735	-352.83	151	SEG25	1834.5	356	231	SEG104	-1928.5	356
72	VSS	1280.735	-352.83	152	SEG26	1787.5	356	232	SEG105	-1975.5	356
73	CLS	1362.585	-352.83	153	SEG27	1740.5	356	233	SEG106	-2022.5	356
74	VDD	1425.285	-352.83	154	SEG28	1693.5	356	234	SEG107	-2069.5	356
75	VDD	1485.885	-352.83	155	SEG29	1646.5	356	235	SEG108	-2116.5	356
76	VDD	1553.185	-352.83	156	SEG30	1599.5	356	236	SEG109	-2163.5	356
77	VDD	1613.185	-352.83	157	SEG31	1552.5	356	237	SEG110	-2210.5	356
78	IREF	1684.585	-352.83	158	SEG32	1505.5	356	238	SEG111	-2257.5	356
79	IREF	1744.585	-352.83	159	SEG33	1458.5	356	239	SEG112	-2304.5	356
80	VCOMH	1815.585	-352.83	160	SEG34	1411.5	356	240	SEG113	-2351.5	356

## 6 PIN DESCRIPTION

**Key:**

I = Input	NC = Not Connected
O = Output	Pull LOW= connect to Ground
I/O = Bi-directional (input/output)	Pull HIGH= connect to V <sub>DD</sub>
P = Power pin	

**Figure 6-1 Pin Description**

Pin Name	Type	Description
V <sub>DD</sub>	P	Power supply pin for core logic operation.
V <sub>CC</sub>	P	Power supply for panel driving voltage. This is also the most positive power voltage supply pin.
V <sub>SS</sub>	P	This is a ground pin.
V <sub>LSS</sub>	P	This is an analog ground pin. It should be connected to V <sub>SS</sub> externally.
V <sub>COMH</sub>	O	The pin for COM signal deselected voltage level. A capacitor should be connected between this pin and V <sub>SS</sub> .
V <sub>DD1</sub>	P	Reserved pin. It should be kept NC.
BGGND	P	Reserved pin. It should be connected to ground.
BS[2:0]	I	MCU bus interface selection pins. Please refer to <b>Table 6-1</b> for the details of setting.
I <sub>REF</sub>	I	This is segment output current reference pin. When external I <sub>REF</sub> is used, a resistor should be connected between this pin and V <sub>SS</sub> to maintain the I <sub>REF</sub> current at 19 uA. Please refer to <b>Figure 7-15</b> for the details of resistor value.  When internal I <sub>REF</sub> is used, this pin should be kept NC.
FR	O	This pin outputs RAM write synchronization signal. Proper timing between MCU data writing and frame display timing can be achieved to prevent tearing effect. It should be kept NC if it is not used. Please refer to Section 7.4 for details usage.
CL	I	This is external clock input pin. When internal clock is enabled (i.e. HIGH in CLS pin), this pin is not used and should be connected to V <sub>SS</sub> . When internal clock is disabled (i.e. LOW in CLS pin), this pin is the external clock source input pin.
CLS	I	This is internal clock enable pin. When it is pulled HIGH (i.e. connect to V <sub>DD</sub> ), internal clock is enabled. When it is pulled LOW, the internal clock is disabled; an external clock source must be connected to the CL pin for normal operation.
RES#	I	This pin is reset signal input. When the pin is pulled LOW, initialization of the chip is executed. Keep this pin HIGH (i.e. connect to V <sub>DD</sub> ) during normal operation.
CS#	I	This pin is the chip select input. (active LOW).

Pin Name	Type	Description
D/C#	I	<p>This is Data/Command control pin. When it is pulled HIGH (i.e. connect to V<sub>DD</sub>), the data at D[7:0] is treated as data. When it is pulled LOW, the data at D[7:0] will be transferred to the command register.</p> <p>In I<sup>2</sup>C mode, this pin acts as SA0 for slave address selection.</p> <p>When 3-wire serial interface is selected, this pin must be connected to V<sub>SS</sub>.</p> <p>For detail relationship to MCU interface signals, please refer to the Timing Characteristics Diagrams: <b>Figure 12-1</b> to <b>Figure 12-5</b>.</p>
E (RD#)	I	<p>When interfacing to a 6800-series microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled HIGH (i.e. connect to V<sub>DD</sub>) and the chip is selected.</p> <p>When connecting to an 8080-series microprocessor, this pin receives the Read (RD#) signal. Read operation is initiated when this pin is pulled LOW and the chip is selected.</p> <p>When serial or I<sup>2</sup>C interface is selected, this pin must be connected to V<sub>SS</sub>.</p>
R/W#(WR#)	I	<p>This is read / write control input pin connecting to the MCU interface.</p> <p>When interfacing to a 6800-series microprocessor, this pin will be used as Read/Write (R/W#) selection input. Read mode will be carried out when this pin is pulled HIGH (i.e. connect to V<sub>DD</sub>) and write mode when LOW.</p> <p>When 8080 interface mode is selected, this pin will be the Write (WR#) input. Data write operation is initiated when this pin is pulled LOW and the chip is selected.</p> <p>When serial or I<sup>2</sup>C interface is selected, this pin must be connected to V<sub>SS</sub>.</p>
D[7:0]	IO	<p>These are 8-bit bi-directional data bus to be connected to the microprocessor's data bus.</p> <p>When serial interface mode is selected, D0 will be the serial clock input: SCLK; D1 will be the serial data input: SDIN and D2 should be kept NC.</p> <p>When I<sup>2</sup>C mode is selected, D2, D1 should be tied together and serve as SDA<sub>out</sub>, SDA<sub>in</sub> in application and D0 is the serial clock input, SCL.</p>
TR0-TR11	-	Testing reserved pins. It should be kept NC.
SEG0 ~ SEG127	O	These pins provide Segment switch signals to OLED panel. These pins are V <sub>SS</sub> state when display is OFF.
COM0 ~ COM63	O	These pins provide Common switch signals to OLED panel. They are in high impedance state when display is OFF.
NC	-	This is dummy pin. Do not group or short NC pins together.

Table 6-1 : MCU Bus Interface Pin Selection

SSD1308 Pin Name	I <sup>2</sup> C Interface	6800-parallel interface (8 bit)	8080-parallel interface (8 bit)	4-wire Serial interface	3-wire Serial interface
BS0	0	0	0	0	1
BS1	1	0	1	0	0
BS2	0	1	1	0	0

**Note**

<sup>(1)</sup> 0 is connected to V<sub>SS</sub>

<sup>(2)</sup> 1 is connected to V<sub>DD</sub>

## 7 FUNCTIONAL BLOCK DESCRIPTIONS

### 7.1 MCU Interface selection

SSD1308 MCU interface consist of 8 data pins and 5 control pins. The pin assignment at different interface mode is summarized in Table 7-1. Different MCU mode can be set by hardware selection on BS[2:0] pins (please refer to Table 6-1 for BS[2:0] setting).

**Table 7-1 : MCU interface assignment under different bus interface mode**

Pin Name Bus Interface	Data/Command Interface								Control Signal				
	D7	D6	D5	D4	D3	D2	D1	D0	E	R/W#	CS#	D/C#	RES#
8-bit 8080	D[7:0]								RD#	WR#	CS#	D/C#	RES#
8-bit 6800	D[7:0]								E	R/W#	CS#	D/C#	RES#
3-wire SPI	Tie LOW			NC	SDIN	SCLK	Tie LOW		CS#	Tie LOW		RES#	
4-wire SPI	Tie LOW			NC	SDIN	SCLK	Tie LOW		CS#	D/C#		RES#	
I <sup>2</sup> C	Tie LOW			SDA <sub>OUT</sub>	SDA <sub>IN</sub>	SCL	Tie LOW		SA0	RES#			

#### 7.1.1 MCU Parallel 6800-series Interface

The parallel interface consists of 8 bi-directional data pins (D[7:0]), R/W#, D/C#, E and CS#.

A LOW in R/W# indicates WRITE operation and HIGH in R/W# indicates READ operation.

A LOW in D/C# indicates COMMAND read/write and HIGH in D/C# indicates DATA read/write.

The E input serves as data latch signal while CS# is LOW. Data is latched at the falling edge of E signal.

**Table 7-2 : Control pins of 6800 interface**

Function	E	R/W#	CS#	D/C#
Write command	↓	L	L	L
Read status	↓	H	L	L
Write data	↓	L	L	H
Read data	↓	H	L	H

#### Note

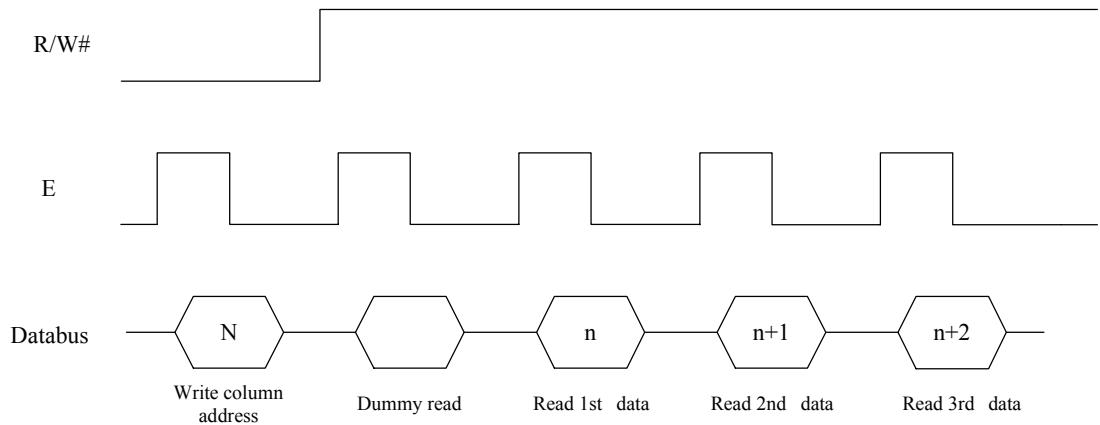
<sup>(1)</sup> ↓ stands for falling edge of signal

H stands for HIGH in signal

L stands for LOW in signal

In order to match the operating frequency of display RAM with that of the microprocessor, some pipeline processing is internally performed which requires the insertion of a dummy read before the first actual display data read. This is shown in Figure 7-1.

**Figure 7-1 : Data read back procedure - insertion of dummy read**

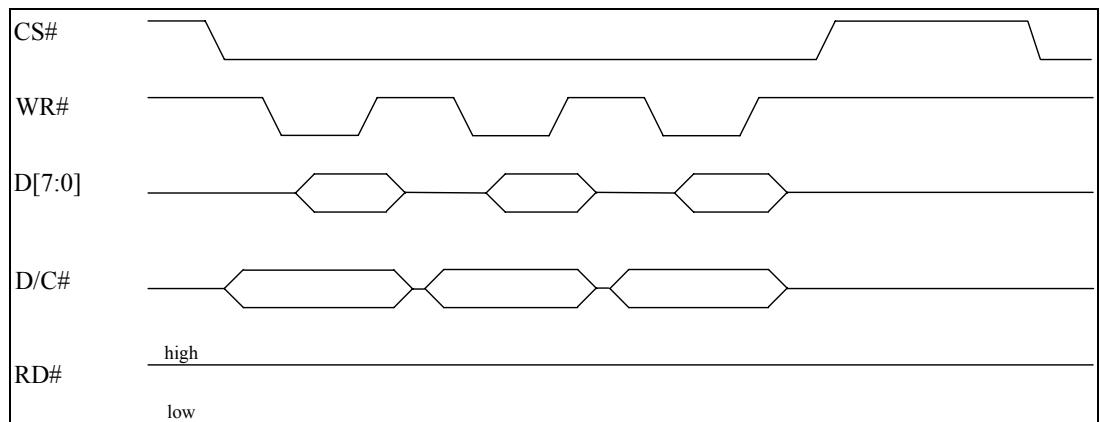


### 7.1.2 MCU Parallel 8080-series Interface

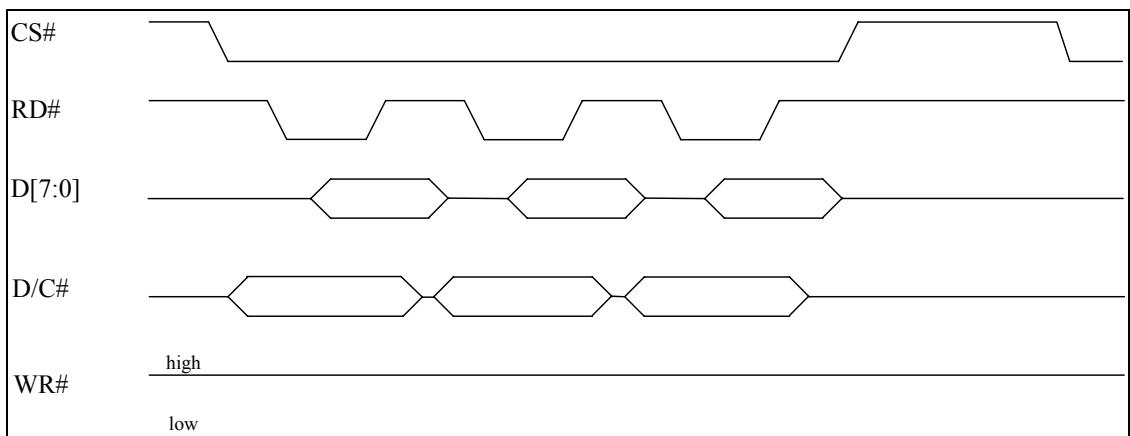
The parallel interface consists of 8 bi-directional data pins (D[7:0]), RD#, WR#, D/C# and CS#.

A LOW in D/C# indicates COMMAND read/write and HIGH in D/C# indicates DATA read/write.  
 A rising edge of RD# input serves as a data READ latch signal while CS# is kept LOW.  
 A rising edge of WR# input serves as a data/command WRITE latch signal while CS# is kept LOW.

**Figure 7-2 : Example of Write procedure in 8080 parallel interface mode**



**Figure 7-3 : Example of Read procedure in 8080 parallel interface mode**



**Table 7-3 : Control pins of 8080 interface**

Function	RD#	WR#	CS#	D/C#
Write command	H	↑	L	L
Read status	↑	H	L	L
Write data	H	↑	L	H
Read data	↑	H	L	H

**Note**

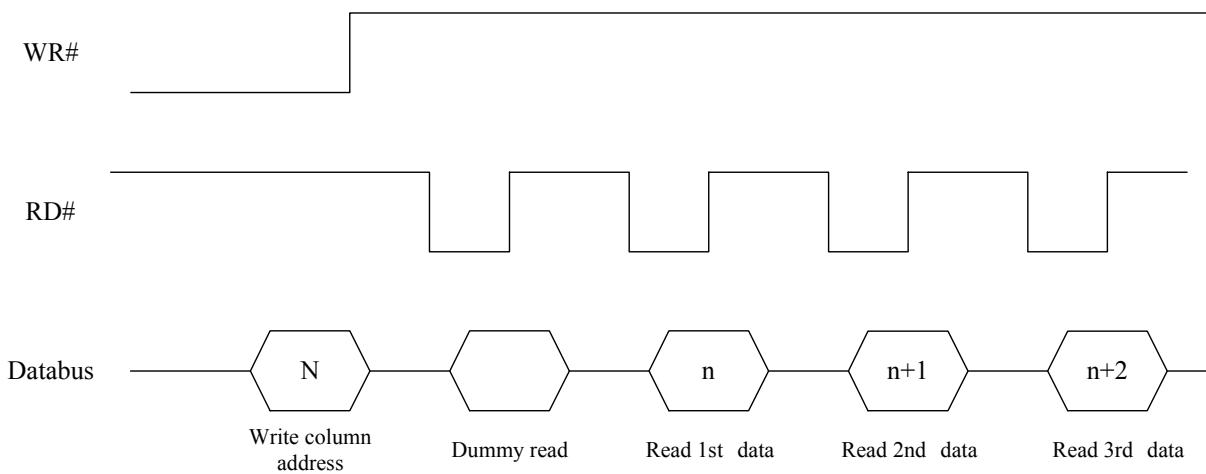
(<sup>1</sup>) ↑ stands for rising edge of signal

(<sup>2</sup>) H stands for HIGH in signal

(<sup>3</sup>) L stands for LOW in signal

In order to match the operating frequency of display RAM with that of the microprocessor, some pipeline processing is internally performed which requires the insertion of a dummy read before the first actual display data read. This is shown in Figure 7-4.

**Figure 7-4 : Display data read back procedure - insertion of dummy read**



### 7.1.3 MCU Serial Interface (4-wire SPI)

The 4-wire serial interface consists of serial clock: SCLK, serial data: SDIN, D/C#, CS#. In 4-wire SPI mode, D0 acts as SCLK, D1 acts as SDIN. For the unused data pins, D2 should be left open. The pins from D3 to D7, E and R/W# (WR#) can be connected to an external ground.

**Table 7-4 : Control pins of 4-wire Serial interface**

Function	E(RD#)	R/W#(WR#)	CS#	D/C#	D0
Write command	Tie LOW	Tie LOW	L	L	↑
Write data	Tie LOW	Tie LOW	L	H	↑

**Note**

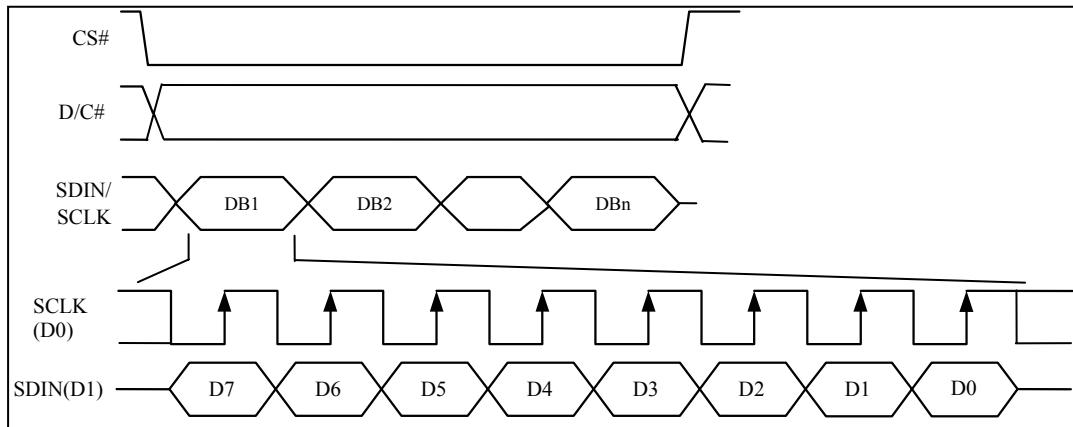
(<sup>1</sup>) H stands for HIGH in signal

(<sup>2</sup>) L stands for LOW in signal

SDIN is shifted into an 8-bit shift register on every rising edge of SCLK in the order of D7, D6, ... D0. D/C# is sampled on every eighth clock and the data byte in the shift register is written to the Graphic Display Data RAM (GDDRAM) or command register in the same clock.

Under serial mode, only write operations are allowed.

**Figure 7-5 : Write procedure in 4-wire Serial interface mode**



#### 7.1.4 MCU Serial Interface (3-wire SPI)

The 3-wire serial interface consists of serial clock SCLK, serial data SDIN and CS#.

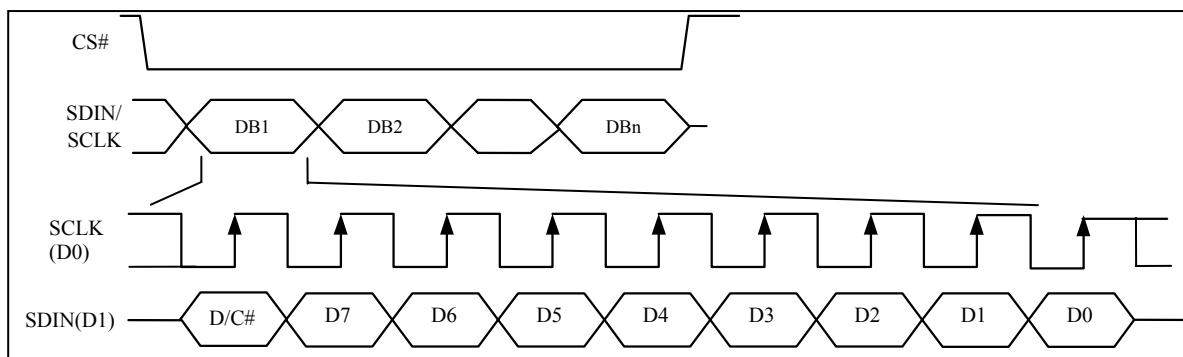
In 3-wire SPI mode, D0 acts as SCLK, D1 acts as SDIN. For the unused data pins, D2 should be left open. The pins from D3 to D7, R/W#(WR#), E and D/C# can be connected to an external ground.

The operation is similar to 4-wire serial interface while D/C# pin is not used. There are altogether 9-bits will be shifted into the shift register on every ninth clock in sequence: D/C# bit, D7 to D0 bit. The D/C# bit (first bit of the sequential data) will determine the following data byte in the shift register is written to the Display Data RAM (D/C# bit = 1) or the command register (D/C# bit = 0). Under serial mode, only write operations are allowed.

**Table 7-5 : Control pins of 3-wire Serial interface**

Function	E(RD#)	R/W#(WR#)	CS#	D/C#	D0	Note
Write command	Tie LOW	Tie LOW	L	Tie LOW	↑	( <sup>1</sup> ) L stands for LOW in signal
Write data	Tie LOW	Tie LOW	L	Tie LOW	↑	

**Figure 7-6 : Write procedure in 3-wire Serial interface mode**



### 7.1.5 MCU I<sup>2</sup>C Interface

The I<sup>2</sup>C communication interface consists of slave address bit SA0, I<sup>2</sup>C-bus data signal SDA (SDA<sub>OUT</sub>/D<sub>2</sub> for output and SDA<sub>IN</sub>/D<sub>1</sub> for input) and I<sup>2</sup>C-bus clock signal SCL (D<sub>0</sub>). Both the data and clock signals must be connected to pull-up resistors. RES# is used for the initialization of device.

a) Slave address bit (SA0)

SSD1308 has to recognize the slave address before transmitting or receiving any information by the I<sup>2</sup>C-bus. The device will respond to the slave address following by the slave address bit (“SA0” bit) and the read/write select bit (“R/W#” bit) with the following byte format,

b<sub>7</sub> b<sub>6</sub> b<sub>5</sub> b<sub>4</sub> b<sub>3</sub> b<sub>2</sub> b<sub>1</sub> b<sub>0</sub>  
0 1 1 1 1 0 SA0 R/W#

“SA0” bit provides an extension bit for the slave address. Either “0111100” or “0111101”, can be selected as the slave address of SSD1308. D/C# pin acts as SA0 for slave address selection.

“R/W#” bit is used to determine the operation mode of the I<sup>2</sup>C-bus interface. R/W#=1, it is in read mode. R/W#=0, it is in write mode.

b) I<sup>2</sup>C-bus data signal (SDA)

SDA acts as a communication channel between the transmitter and the receiver. The data and the acknowledgement are sent through the SDA.

It should be noticed that the ITO track resistance and the pulled-up resistance at “SDA” pin becomes a voltage potential divider. As a result, the acknowledgement would not be possible to attain a valid logic 0 level in “SDA”.

“SDA<sub>IN</sub>” and “SDA<sub>OUT</sub>” are tied together and serve as SDA. The “SDA<sub>IN</sub>” pin must be connected to act as SDA. The “SDA<sub>OUT</sub>” pin may be disconnected. When “SDA<sub>OUT</sub>” pin is disconnected, the acknowledgement signal will be ignored in the I<sup>2</sup>C-bus.

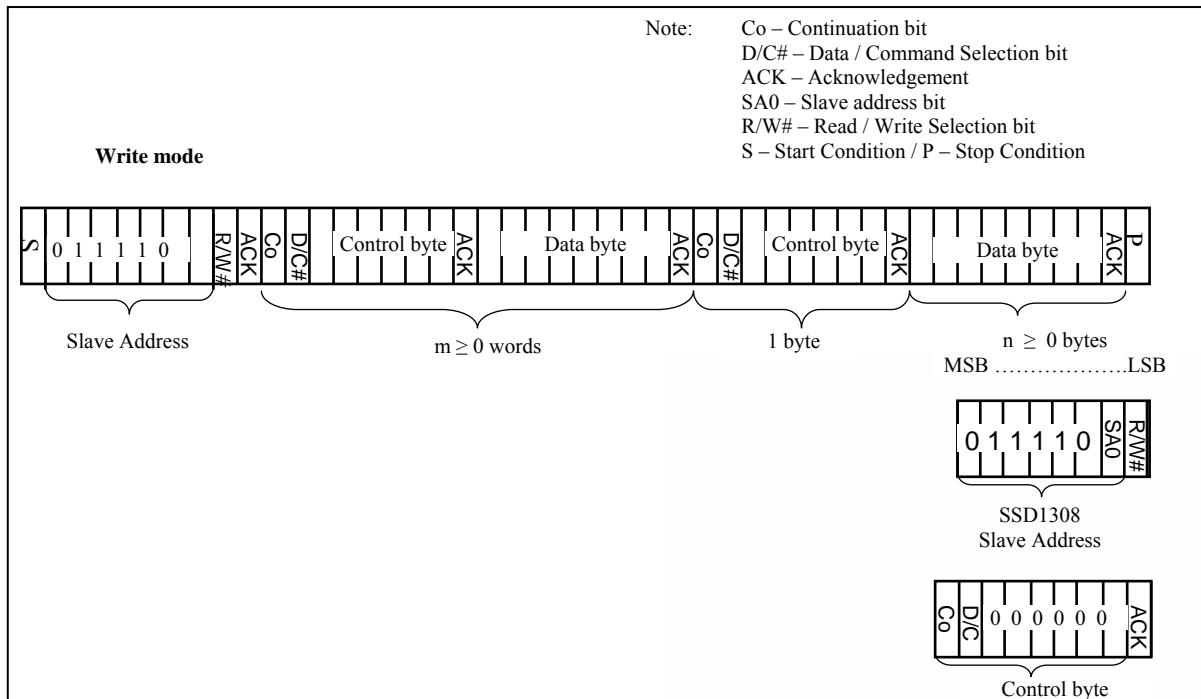
c) I<sup>2</sup>C-bus clock signal (SCL)

The transmission of information in the I<sup>2</sup>C-bus is following a clock signal, SCL. Each transmission of data bit is taken place during a single clock period of SCL.

### 7.1.5.1 I<sup>2</sup>C-bus Write data

The I<sup>2</sup>C-bus interface gives access to write data and command into the device. Please refer to Figure 7-7 for the write mode of I<sup>2</sup>C-bus in chronological order.

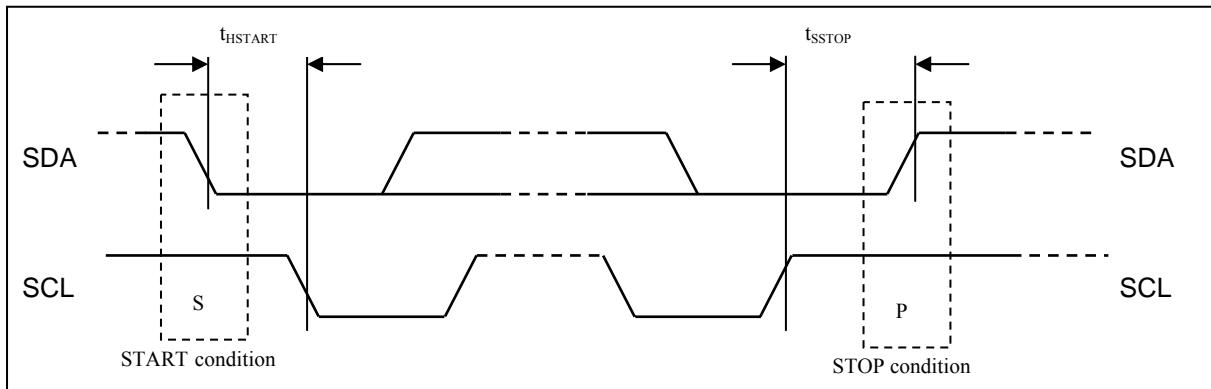
**Figure 7-7 : I<sup>2</sup>C-bus data format**



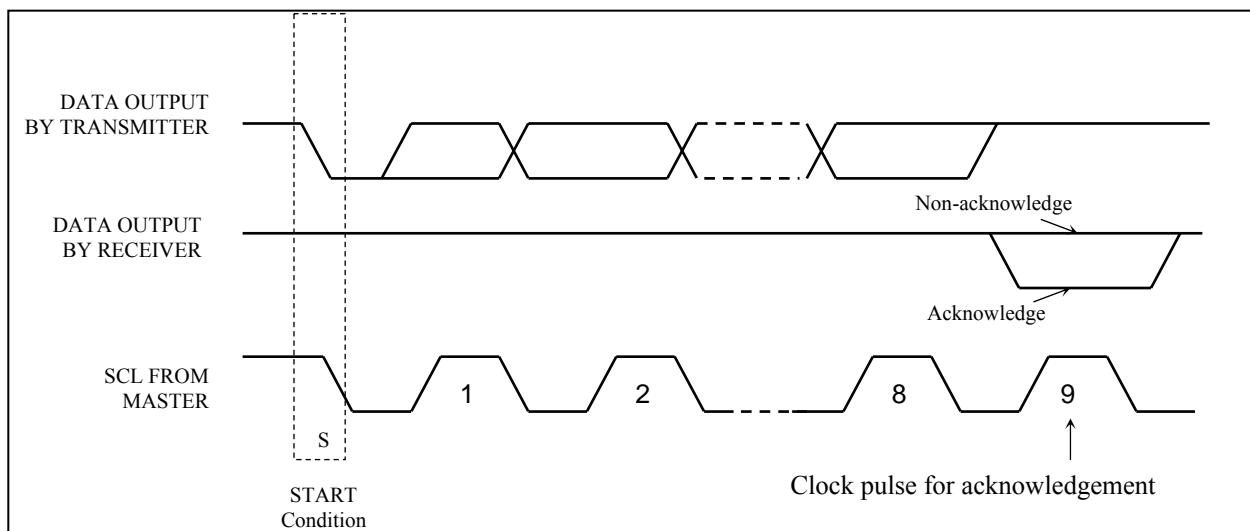
### 7.1.5.2 Write mode for I<sup>2</sup>C

- 1) The master device initiates the data communication by a start condition. The definition of the start condition is shown in Figure 7-8. The start condition is established by pulling the SDA from HIGH to LOW while the SCL stays HIGH.
- 2) The slave address is following the start condition for recognition use. For the SSD1308, the slave address is either “b0111100” or “b0111101” by changing the SA0 to LOW or HIGH (D/C pin acts as SA0).
- 3) The write mode is established by setting the R/W# bit to logic “0”.
- 4) An acknowledgement signal will be generated after receiving one byte of data, including the slave address and the R/W# bit. Please refer to the Figure 7-9 for the graphical representation of the acknowledge signal. The acknowledge bit is defined as the SDA line is pulled down during the HIGH period of the acknowledgement related clock pulse.
- 5) After the transmission of the slave address, either the control byte or the data byte may be sent across the SDA. A control byte mainly consists of Co and D/C# bits following by six “0” ‘s.
  - a. If the Co bit is set as logic “0”, the transmission of the following information will contain data bytes only.
  - b. The D/C# bit determines the next data byte is acted as a command or a data. If the D/C# bit is set to logic “0”, it defines the following data byte as a command. If the D/C# bit is set to logic “1”, it defines the following data byte as a data which will be stored at the GDDRAM. The GDDRAM column address pointer will be increased by one automatically after each data write.
- 6) Acknowledge bit will be generated after receiving each control byte or data byte.
- 7) The write mode will be finished when a stop condition is applied. The stop condition is also defined in Figure 7-8. The stop condition is established by pulling the “SDA in” from LOW to HIGH while the “SCL” stays HIGH.

**Figure 7-8 : Definition of the Start and Stop Condition**



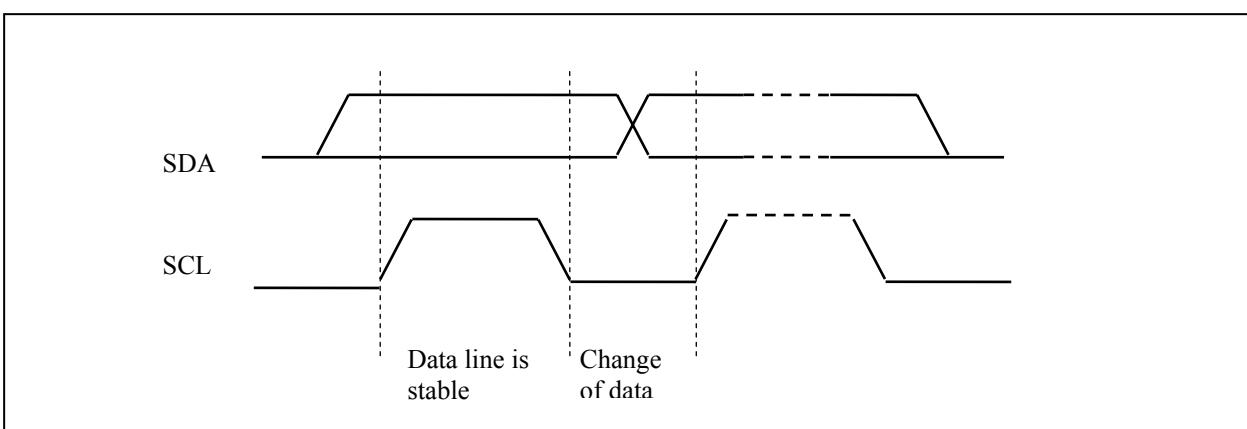
**Figure 7-9 : Definition of the acknowledgement condition**



Please be noted that the transmission of the data bit has some limitations.

1. The data bit, which is transmitted during each SCL pulse, must keep at a stable state within the “HIGH” period of the clock pulse. Please refer to the Figure 7-10 for graphical representations. Except in start or stop conditions, the data line can be switched only when the SCL is LOW.
2. Both the data line (SDA) and the clock line (SCL) should be pulled up by external resistors.

**Figure 7-10 : Definition of the data transfer condition**



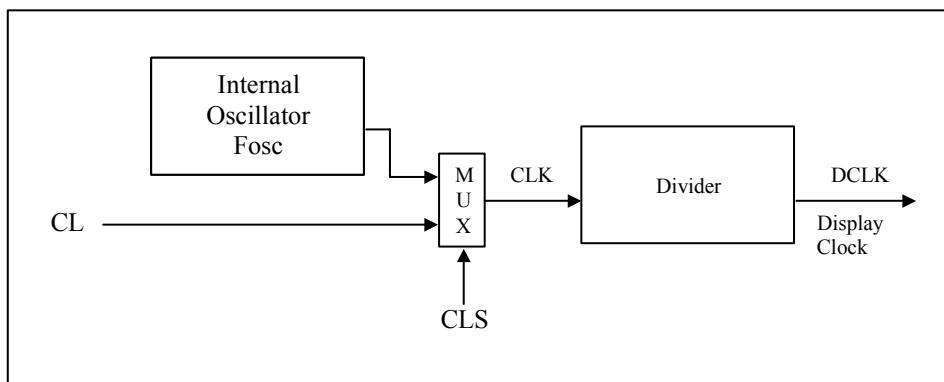
## 7.2 Command Decoder

This module determines whether the input data is interpreted as data or command. Data is interpreted based upon the input of the D/C# pin.

If D/C# pin is HIGH, D[7:0] is interpreted as display data written to Graphic Display Data RAM (GDDRAM). If it is LOW, the input at D[7:0] is interpreted as a command. Then data input will be decoded and written to the corresponding command register.

## 7.3 Oscillator Circuit and Display Time Generator

**Figure 7-11 : Oscillator Circuit and Display Time Generator**



This module is an on-chip LOW power RC oscillator circuitry. The operation clock (CLK) can be generated either from internal oscillator or external source CL pin. This selection is done by CLS pin. If CLS pin is pulled HIGH, internal oscillator is chosen and CL should be left open. Pulling CLS pin LOW disables internal oscillator and external clock must be connected to CL pins for proper operation. When the internal oscillator is selected, its output frequency Fosc can be changed by command D5h A[7:4].

The display clock (DCLK) for the Display Timing Generator is derived from CLK. The division factor “D” can be programmed from 1 to 16 by command D5h

$$DCLK = F_{OSC} / D$$

The frame frequency of display is determined by the following formula.

$$F_{FRM} = \frac{F_{osc}}{D \times K \times \text{No. of Mux}}$$

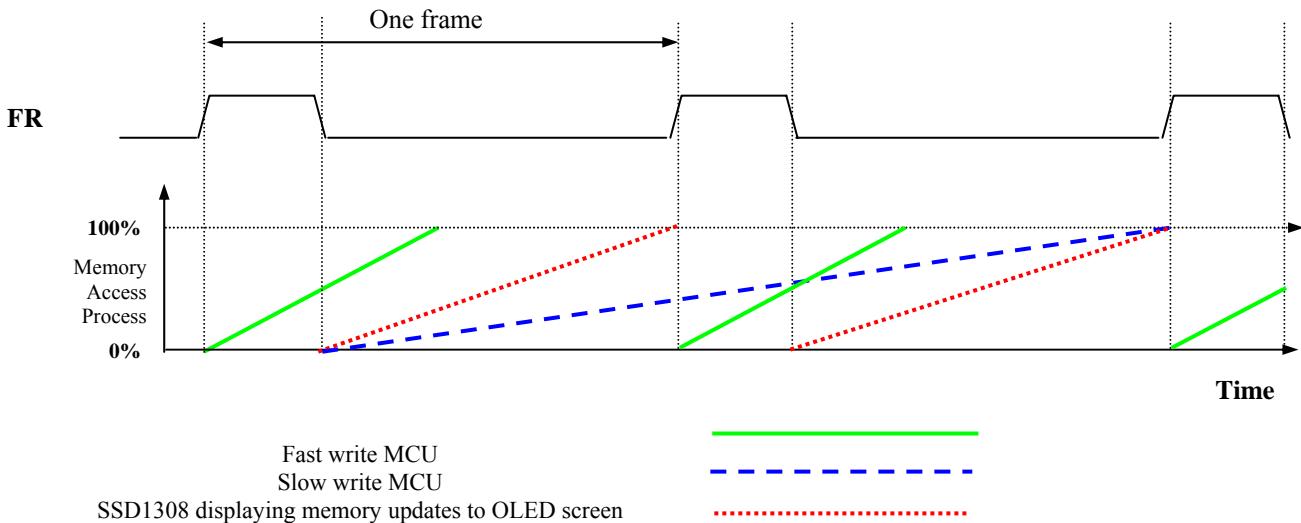
where

- D stands for clock divide ratio. It is set by command D5h A[3:0]. The divide ratio has the range from 1 to 16.
- K is the number of display clocks per row. The value is derived by
 
$$K = \text{Phase 1 period} + \text{Phase 2 period} + \text{BANK0 pulse width}$$

$$= 2 + 2 + 50 = 54 \text{ at power on reset}$$
 (Please refer to Section 7.6 “Segment Drivers / Common Drivers” for the details of the “Phase”)
- Number of multiplex ratio is set by command A8h. The power on reset value is 63 (i.e. 64MUX).
- Fosc is the oscillator frequency. It can be changed by command D5h A[7:4]. The higher the register setting results in higher frequency.

## 7.4 FR synchronization

FR synchronization signal can be used to prevent tearing effect.



The starting time to write a new image to OLED driver is depended on the MCU writing speed. If MCU can finish writing a frame image within one frame period, it is classified as fast write MCU. For MCU needs longer writing time to complete (more than one frame but within two frames), it is a slow write one.

**For fast write MCU:** MCU should start to write new frame of ram data just after rising edge of FR pulse and should be finished well before the rising edge of the next FR pulse.

**For slow write MCU:** MCU should start to write new frame ram data after the falling edge of the 1<sup>st</sup> FR pulse and must be finished before the rising edge of the 3<sup>rd</sup> FR pulse.

## 7.5 Reset Circuit

When RES# input is LOW, the chip is initialized with the following status:

1. Display is OFF
2. 128 x 64 Display Mode
3. Normal segment and display data column address and row address mapping (SEG0 mapped to address 00h and COM0 mapped to address 00h)
4. Shift register data clear in serial interface
5. Display start line is set at display RAM address 0
6. Column address counter is set at 0
7. Normal scan direction of the COM outputs
8. Contrast control register is set at 7Fh
9. Normal display mode (Equivalent to A4h command)

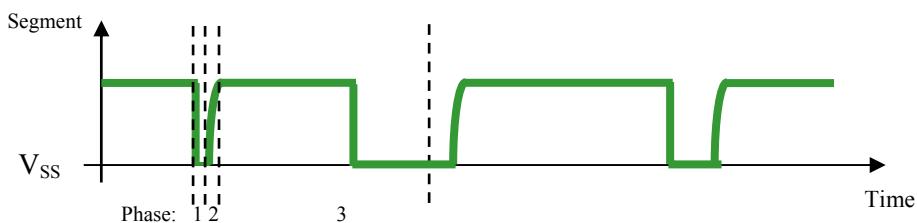
## 7.6 Segment Drivers / Common Drivers

Segment drivers deliver 128 current sources to drive the OLED panel. The driving current can be adjusted from 0 to 150uA with 256 steps. Common drivers generate voltage-scanning pulses.

The segment driving waveform is divided into three phases:

1. In phase 1, the OLED pixel charges of previous image are discharged in order to prepare for next image content display.
2. In phase 2, the OLED pixel is driven to the targeted voltage. The pixel is driven to attain the corresponding voltage level from  $V_{SS}$ . The period of phase 2 can be programmed in length from 1 to 15 DCLKs. If the capacitance value of the pixel of OLED panel is larger, a longer period is required to charge up the capacitor to reach the desired voltage.
3. In phase 3, the OLED driver switches to use current source to drive the OLED pixels and this is the current drive stage.

**Figure 7-12 : Segment Output Waveform in three phases**



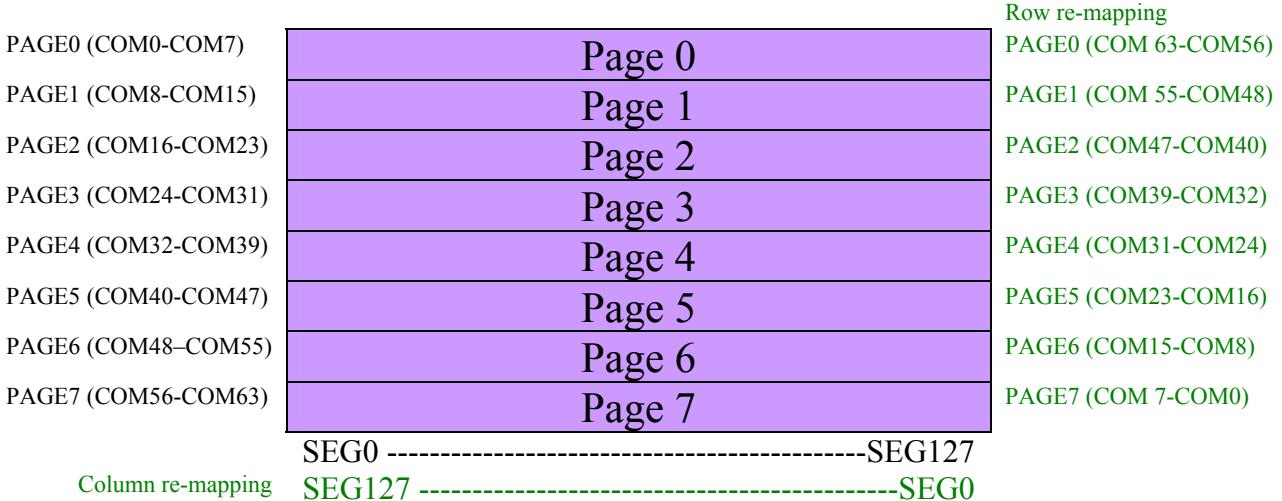
After finishing phase 3, the driver IC will go back to phase 1 to display the next row image data. This three-step cycle is run continuously to refresh image display on OLED panel.

In phase 3, if the length of current drive pulse width is set to 50, after finishing 50 DCLKs in current drive phase, the driver IC will go back to phase 1 for next row display.

## 7.7 Graphic Display Data RAM (GDDRAM)

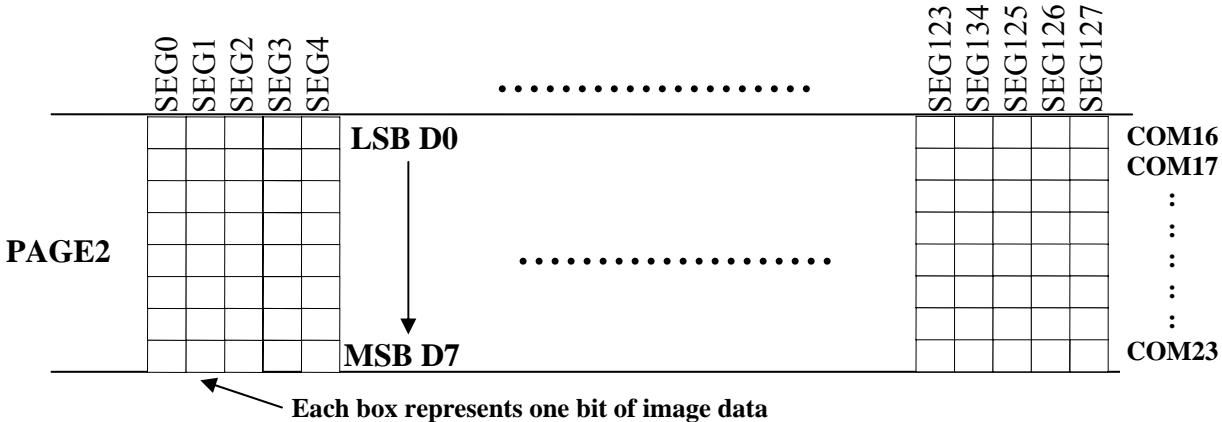
The GDDRAM is a bit mapped static RAM holding the bit pattern to be displayed. The size of the RAM is 128 x 64 bits and the RAM is divided into eight pages, from PAGE0 to PAGE7, which are used for monochrome 128x64 dot matrix display, as shown in Figure 7-13.

**Figure 7-13 : GDDRAM pages structure of SSD1308**



When one data byte is written into GDDRAM, all the rows image data of the same page of the current column are filled (i.e. the whole column (8 bits) pointed by the column address pointer is filled.). Data bit D0 is written into the top row, while data bit D7 is written into bottom row as shown in Figure 7-14.

**Figure 7-14 : Enlargement of GDDRAM (No row re-mapping and column-remapping)**



For mechanical flexibility, re-mapping on both Segment and Common outputs can be selected by software as shown in Figure 7-13.

For vertical shifting of the display, an internal register storing the display start line can be set to control the portion of the RAM data to be mapped to the display (command D3h).

## 7.8 SEG/COM Driving block

This block is used to derive the incoming power sources into the different levels of internal use voltage and current.

- $V_{CC}$  is the most positive voltage supply.
- $V_{COMH}$  is the Common deselected level. It is internally regulated.
- $V_{LSS}$  is the ground path of the analog and panel current.
- $I_{REF}$  is a reference current source for segment current drivers  $I_{SEG}$ . The relationship between reference current and segment current of a color is:

$$I_{SEG} = \text{Contrast} / 256 \times I_{REF} \times \text{scale factor}$$

in which

the contrast (0~255) is set by Set Contrast command 81h; and  
the scale factor is 8 by default.

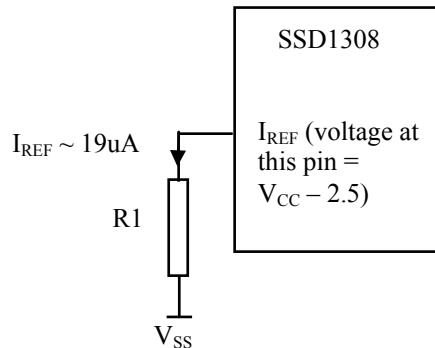
Bit A[4] of command ADh is used to select external or internal  $I_{REF}$ :

A[4] = '0' Select external  $I_{REF}$  [Reset]

A[4] = '1' Enable internal  $I_{REF}$  during display ON

When external  $I_{REF}$  is used, the magnitude of  $I_{REF}$  is controlled by the value of resistor, which is connected between  $I_{REF}$  pin and  $V_{SS}$  as shown in Figure 7-15. It is recommended to set  $I_{REF}$  to  $19 \pm 2\mu\text{A}$  so as to achieve  $I_{SEG} = 150\mu\text{A}$  at maximum contrast 255.

**Figure 7-15 :  $I_{REF}$  Current Setting by Resistor Value**



Since the voltage at  $I_{REF}$  pin is  $V_{CC} - 2.5\text{V}$ , the value of resistor R1 can be found as below:

For  $I_{REF} = 19\mu\text{A}$ ,  $V_{CC} = 12\text{V}$ :

$$\begin{aligned} R1 &= (\text{Voltage at } I_{REF} - V_{SS}) / I_{REF} \\ &= (12 - 2.5) / 19\mu\text{A} \\ &= 500\text{K}\Omega \end{aligned}$$

When internal  $I_{REF}$  is used, the  $I_{REF}$  pin should be kept NC and the  $I_{SEG}$  is set as  $150\mu\text{A}$ .

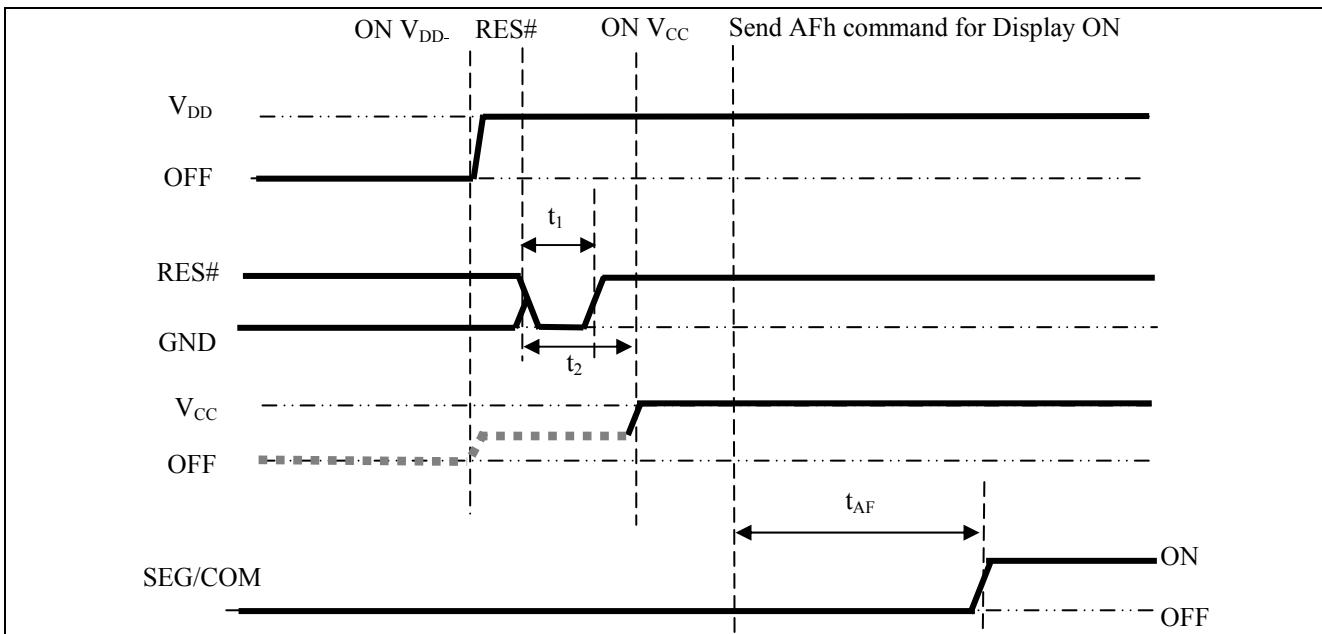
## 7.9 Power ON and OFF sequence

The following figures illustrate the recommended power ON and power OFF sequence of SSD1308

*Power ON sequence:*

1. Power ON V<sub>DD</sub>
2. After V<sub>DD</sub> become stable, set RES# pin LOW (logic low) for at least 3us ( $t_1$ ) <sup>(4)</sup> and then HIGH (logic high).
3. After set RES# pin LOW (logic low), wait for at least 3us ( $t_2$ ). Then Power ON V<sub>CC</sub>.<sup>(1)</sup>
4. After V<sub>CC</sub> become stable, send command AFh for display ON. SEG/COM will be ON after 100ms ( $t_{AF}$ ).

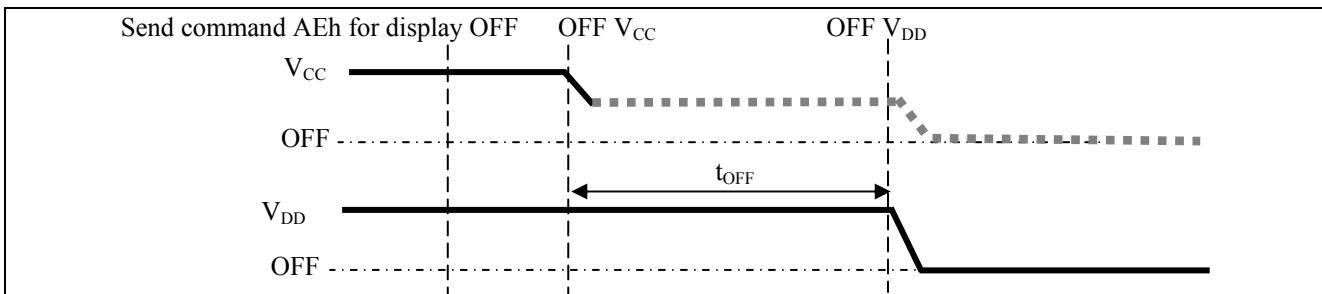
**Figure 7-16 : The Power ON sequence**



*Power OFF sequence:*

1. Send command AEh for display OFF.
2. Power OFF V<sub>CC</sub>.<sup>(1),(2),(3)</sup>
3. Power OFF V<sub>DD</sub> after t<sub>OFF</sub>.<sup>(5)</sup> (Typical t<sub>OFF</sub>=100ms)

**Figure 7-17 : The Power OFF sequence**



### Note:

- <sup>(1)</sup> Since an ESD protection circuit is connected between V<sub>DD</sub> and V<sub>CC</sub>, V<sub>CC</sub> becomes lower than V<sub>DD</sub> whenever V<sub>DD</sub> is ON and V<sub>CC</sub> is OFF as shown in the dotted line of V<sub>CC</sub> in Figure 7-16 and Figure 7-17.
- <sup>(2)</sup> V<sub>CC</sub> should be kept float (i.e. disable) when it is OFF.
- <sup>(3)</sup> Power Pins (V<sub>DD</sub>, V<sub>CC</sub>) can never be pulled to ground under any circumstance.
- <sup>(4)</sup> The register values are reset after  $t_1$ .
- <sup>(5)</sup> V<sub>DD</sub> should not be Power OFF before V<sub>CC</sub> Power OFF.

## 8 COMMAND TABLE

**Table 8-1: Command Table**

(D/C#=0, R/W#(WR#) = 0, E(RD#=1) unless specific setting is stated)

Fundamental Command Table											
D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	00~0F	0	0	0	0	X <sub>3</sub>	X <sub>2</sub>	X <sub>1</sub>	X <sub>0</sub>	Set Lower Column Start Address for Page Addressing Mode	Set the lower nibble of the column start address register for Page Addressing Mode using X[3:0] as data bits. The initial display line register is reset to 0000b after RESET.  <b>Note</b> <sup>(1)</sup> This command is only for page addressing mode
0	10~1F	0	0	0	1	X <sub>3</sub>	X <sub>2</sub>	X <sub>1</sub>	X <sub>0</sub>	Set Higher Column Start Address for Page Addressing Mode	Set the higher nibble of the column start address register for Page Addressing Mode using X[3:0] as data bits. The initial display line register is reset to 0000b after RESET.  <b>Note</b> <sup>(1)</sup> This command is only for page addressing mode
0 0	20 A[1:0]	0 * *	0 * *	1 * *	0 * *	0 * *	0 * *	0 A <sub>1</sub>	0 A <sub>0</sub>	Set Memory Addressing Mode	A[1:0] = 00b, Horizontal Addressing Mode A[1:0] = 01b, Vertical Addressing Mode A[1:0] = 10b, Page Addressing Mode (RESET) A[1:0] = 11b, Invalid
0 0 0	21 A[6:0] B[6:0]	0 * *	0 A <sub>6</sub> B <sub>6</sub>	1 A <sub>5</sub> B <sub>5</sub>	0 A <sub>4</sub> B <sub>4</sub>	0 A <sub>3</sub> B <sub>3</sub>	0 A <sub>2</sub> B <sub>2</sub>	0 A <sub>1</sub> B <sub>1</sub>	1 A <sub>0</sub> B <sub>0</sub>	Set Column Address	Setup column start and end address A[6:0] : Column start address, range : 0-127d, (RESET=0d)  B[6:0]: Column end address, range : 0-127d, (RESET =127d)  <b>Note</b> <sup>(1)</sup> This command is only for horizontal or vertical addressing mode.
0 0 0	22 A[2:0] B[2:0]	0 * *	0 * *	1 * *	0 * *	0 * *	0 A <sub>2</sub> B <sub>2</sub>	1 A <sub>1</sub> B <sub>1</sub>	0 A <sub>0</sub> B <sub>0</sub>	Set Page Address	Setup page start and end address A[2:0] : Page start Address, range : 0-7d, (RESET = 0d) B[2:0] : Page end Address, range : 0-7d, (RESET = 7d)  <b>Note</b> <sup>(1)</sup> This command is only for horizontal or vertical addressing mode.
0	40~7F	0	1	X <sub>5</sub>	X <sub>4</sub>	X <sub>3</sub>	X <sub>2</sub>	X <sub>1</sub>	X <sub>0</sub>	Set Display Start Line	Set display RAM display start line register from 0-63 using X <sub>5</sub> X <sub>3</sub> X <sub>2</sub> X <sub>1</sub> X <sub>0</sub> . Display start line register is reset to 000000b during RESET.
0 0	81 A[7:0]	1 A <sub>7</sub>	0 A <sub>6</sub>	0 A <sub>5</sub>	0 A <sub>4</sub>	0 A <sub>3</sub>	0 A <sub>2</sub>	0 A <sub>1</sub>	1 A <sub>0</sub>	Set Contrast Control	Double byte command to select 1 out of 256 contrast steps. Contrast increases as the value increases. (RESET = 7Fh )

Fundamental Command Table											
D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	A0/A1	1	0	1	0	0	0	0	X <sub>0</sub>	Set Segment Re-map	A0h, X[0]=0b: column address 0 is mapped to SEG0 (RESET) A1h, X[0]=1b: column address 127 is mapped to SEG0
0	A4/A5	1	0	1	0	0	1	0	X <sub>0</sub>	Entire Display ON	A4h, X <sub>0</sub> =0b: Resume to RAM content display (RESET) Output follows RAM content A5h, X <sub>0</sub> =1b: Entire display ON Output ignores RAM content
0	A6/A7	1	0	1	0	0	1	1	X <sub>0</sub>	Set Normal/Inverse Display	A6h, X[0]=0b: Normal display (RESET) 0 in RAM: OFF in display panel 1 in RAM: ON in display panel A7h, X[0]=1b: Inverse display 0 in RAM: ON in display panel 1 in RAM: OFF in display panel
0 0	A8 A[5:0]	1 *	0 *	1 A <sub>5</sub>	0 A <sub>4</sub>	1 A <sub>3</sub>	0 A <sub>2</sub>	0 A <sub>1</sub>	0 A <sub>0</sub>	Set Multiplex Ratio	Set MUX ratio to N+1 MUX N=A[5:0] : from 16MUX to 64MUX, RESET=111111b (i.e. 63d, 64MUX) A[5:0] from 0 to 14 are invalid entry.
0 0	AD A[4]	1 0	0 0	1 0	0 A <sub>4</sub>	1 0	1 0	0 0	1 0	External or internal I <sub>REF</sub> Selection	Select external or internal I <sub>REF</sub> : A[4] = '0' Select external I <sub>REF</sub> (RESET) A[4] = '1' Enable internal I <sub>REF</sub> during display ON  <b>Note</b> <sup>(1)</sup> Refer to section 7.8 for details.
0	AE AF	1	0	1	0	1	1	1	X <sub>0</sub>	Set Display ON/OFF	AEh, X[0]=0b:Display OFF (sleep mode) (RESET) AFh X[0]=1b:Display ON in normal mode
0	B0~B7	1	0	1	1	0	X <sub>2</sub>	X <sub>1</sub>	X <sub>0</sub>	Set Page Start Address for Page Addressing Mode	Set GDDRAM Page Start Address (PAGE0~PAGE7) for Page Addressing Mode using X[2:0].  <b>Note</b> <sup>(1)</sup> This command is only for page addressing mode
0	C0/C8	1	1	0	0	X <sub>3</sub>	0	0	0	Set COM Output Scan Direction	C0h, X[3]=0b: normal mode (RESET) Scan from COM0 to COM[N-1] C8h, X[3]=1b: remapped mode. Scan from COM[N-1] to COM0 Where N is the Multiplex ratio.
0 0	D3 A[5:0]	1 *	1 *	0 A <sub>5</sub>	1 A <sub>4</sub>	0 A <sub>3</sub>	0 A <sub>2</sub>	1 A <sub>1</sub>	1 A <sub>0</sub>	Set Display Offset	Set vertical shift by COM from 0d~63d The value is reset to 00h after RESET.
0 0	D5 A[7:0]	1 A <sub>7</sub>	1 A <sub>6</sub>	0 A <sub>5</sub>	1 A <sub>4</sub>	0 A <sub>3</sub>	1 A <sub>2</sub>	0 A <sub>1</sub>	1 A <sub>0</sub>	Set Display Clock Divide Ratio/Oscillator Frequency	A[3:0] : Define the divide ratio (D) of the display clocks (DCLK): Divide ratio= A[3:0] + 1, RESET is 0000b (divide ratio = 1)  A[7:4] : Set the Oscillator Frequency, F <sub>OSC</sub> . Oscillator Frequency increases with the value of A[7:4] and vice versa. RESET is 1000b Range:0000b~1111b Frequency increases as setting value increases.

Fundamental Command Table																							
D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description												
0 0	D9 A[7:0]	1 A <sub>7</sub>	1 A <sub>6</sub>	0 A <sub>5</sub>	1 A <sub>4</sub>	1 A <sub>3</sub>	0 A <sub>2</sub>	0 A <sub>1</sub>	1 A <sub>0</sub>	Set Pre-charge Period	A[3:0] : Phase 1 period of up to 15 DCLK clocks 0 is invalid entry (RESET=2h)  A[7:4] : Phase 2 period of up to 15 DCLK clocks 0 is invalid entry (RESET=2h )												
0 0	DA A[5:4]	1 0	1 0	0 A <sub>5</sub>	1 A <sub>4</sub>	1 0	0 0	1 1	0 0	Set COM Pins Hardware Configuration	A[4]=0b, Sequential COM pin configuration A[4]=1b(RESET), Alternative COM pin configuration  A[5]=0b(RESET), Disable COM Left/Right remap A[5]=1b, Enable COM Left/Right remap												
0 0	DB A[6:4]	1 0	1 A <sub>6</sub>	0 A <sub>5</sub>	1 A <sub>4</sub>	1 0	0 0	1 0	1 0	Set V <sub>COMH</sub> Deselect Level	<table border="1"> <tr> <td>A[6:4]</td> <td>Hex code</td> <td>V<sub>COMH</sub> deselect level</td> </tr> <tr> <td>000b</td> <td>00h</td> <td>~ 0.65 x V<sub>CC</sub></td> </tr> <tr> <td>010b</td> <td>20h</td> <td>~ 0.77 x V<sub>CC</sub> (RESET)</td> </tr> <tr> <td>011b</td> <td>30h</td> <td>~ 0.83 x V<sub>CC</sub></td> </tr> </table>	A[6:4]	Hex code	V <sub>COMH</sub> deselect level	000b	00h	~ 0.65 x V <sub>CC</sub>	010b	20h	~ 0.77 x V <sub>CC</sub> (RESET)	011b	30h	~ 0.83 x V <sub>CC</sub>
A[6:4]	Hex code	V <sub>COMH</sub> deselect level																					
000b	00h	~ 0.65 x V <sub>CC</sub>																					
010b	20h	~ 0.77 x V <sub>CC</sub> (RESET)																					
011b	30h	~ 0.83 x V <sub>CC</sub>																					
0	E3	1	1	1	0	0	0	1	1	NOP	Command for no operation												

2. Scrolling Command Table																																					
D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description																										
0 0 0 0 0 0 0 0	26/27 A[7:0] B[2:0] C[2:0] D[2:0] E[7:0] F[7:0]	0 0 * * * 0 1	0 0 * * * 0 1	1 0 * * * 0 1	0 0 * * * 0 1	0 0 * * * 0 1	1 0 B <sub>2</sub> C <sub>2</sub> D <sub>2</sub> 0 1	1 0 B <sub>1</sub> C <sub>1</sub> D <sub>1</sub> 0 1	X <sub>0</sub> 0 B <sub>0</sub> C <sub>0</sub> D <sub>0</sub> 0 1	Continuous Horizontal Scroll Setup	<p>26h, X[0]=0, Right Horizontal Scroll 27h, X[0]=1, Left Horizontal Scroll (Horizontal scroll by 1 column)</p> <p>A[7:0] : Dummy byte (Set as 00h) B[2:0] : Define start page address</p> <table border="1"> <tr> <td>000b – PAGE0</td> <td>011b – PAGE3</td> <td>110b – PAGE6</td> </tr> <tr> <td>001b – PAGE1</td> <td>100b – PAGE4</td> <td>111b – PAGE7</td> </tr> <tr> <td>010b – PAGE2</td> <td>101b – PAGE5</td> <td></td> </tr> </table> <p>C[2:0] : Set time interval between each scroll step in terms of frame frequency</p> <table border="1"> <tr> <td>000b – 5 frames</td> <td>100b – 3 frames</td> </tr> <tr> <td>001b – 64 frames</td> <td>101b – 4 frames</td> </tr> <tr> <td>010b – 128 frames</td> <td>110b – 25 frame</td> </tr> <tr> <td>011b – 256 frames</td> <td>111b – 2 frame</td> </tr> </table> <p>D[2:0] : Define end page address</p> <table border="1"> <tr> <td>000b – PAGE0</td> <td>011b – PAGE3</td> <td>110b – PAGE6</td> </tr> <tr> <td>001b – PAGE1</td> <td>100b – PAGE4</td> <td>111b – PAGE7</td> </tr> <tr> <td>010b – PAGE2</td> <td>101b – PAGE5</td> <td></td> </tr> </table> <p>The value of D[2:0] must be larger or equal to B[2:0]</p> <p>E[7:0] : Dummy byte (Set as 00h)</p> <p>F[7:0] : Dummy byte (Set as FFh)</p>	000b – PAGE0	011b – PAGE3	110b – PAGE6	001b – PAGE1	100b – PAGE4	111b – PAGE7	010b – PAGE2	101b – PAGE5		000b – 5 frames	100b – 3 frames	001b – 64 frames	101b – 4 frames	010b – 128 frames	110b – 25 frame	011b – 256 frames	111b – 2 frame	000b – PAGE0	011b – PAGE3	110b – PAGE6	001b – PAGE1	100b – PAGE4	111b – PAGE7	010b – PAGE2	101b – PAGE5	
000b – PAGE0	011b – PAGE3	110b – PAGE6																																			
001b – PAGE1	100b – PAGE4	111b – PAGE7																																			
010b – PAGE2	101b – PAGE5																																				
000b – 5 frames	100b – 3 frames																																				
001b – 64 frames	101b – 4 frames																																				
010b – 128 frames	110b – 25 frame																																				
011b – 256 frames	111b – 2 frame																																				
000b – PAGE0	011b – PAGE3	110b – PAGE6																																			
001b – PAGE1	100b – PAGE4	111b – PAGE7																																			
010b – PAGE2	101b – PAGE5																																				

2. Scrolling Command Table												
D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description	
0	29h/2Ah	0	0	1	0	1	0	X <sub>1</sub>	X <sub>0</sub>	Continuous Vertical and Right Horizontal Scroll	29h, X <sub>1</sub> X <sub>0</sub> =01b : Vertical and Right Horizontal Scroll 2Ah, X <sub>1</sub> X <sub>0</sub> =10b : Vertical and Left Horizontal Scroll	
0	A[2:0]	0	0	0	0	0	0	0	0	Vertical and Horizontal Scroll	(Horizontal scroll by 1 column)	
0	B[2:0]	*	*	*	*	*	B <sub>2</sub>	B <sub>1</sub>	B <sub>0</sub>	Horizontal Scroll Setup	A[7:0] : Dummy byte	
0	C[2:0]	*	*	*	*	*	C <sub>2</sub>	C <sub>1</sub>	C <sub>0</sub>			
0	D[2:0]	*	*	*	*	*	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>			
0	E[5:0]	*	*	E <sub>5</sub>	E <sub>4</sub>	E <sub>3</sub>	E <sub>2</sub>	E <sub>1</sub>	E <sub>0</sub>	B[2:0] : Define start page address	000b – PAGE0   011b – PAGE3   110b – PAGE6 001b – PAGE1   100b – PAGE4   111b – PAGE7 010b – PAGE2   101b – PAGE5	
										C[2:0] : Set time interval between each scroll step in terms of frame frequency	000b – 5 frames   100b – 3 frames 001b – 64 frames   101b – 4 frames 010b – 128 frames   110b – 25 frame 011b – 256 frames   111b – 2 frame	
										D[2:0] : Define end page address	000b – PAGE0   011b – PAGE3   110b – PAGE6 001b – PAGE1   100b – PAGE4   111b – PAGE7 010b – PAGE2   101b – PAGE5	
										The value of D[2:0] must be larger or equal to B[2:0]		
										E[5:0] : Vertical scrolling offset e.g. E[5:0]=01h refer to offset =1 row E[5:0] =3Fh refer to offset =63 rows		
										<b>Note</b> <sup>(1)</sup> No continuous vertical scrolling is available.		
0	2E	0	0	1	0	1	1	1	0	Deactivate scroll	Stop scrolling that is configured by command 26h/27h/29h/2Ah.	
										<b>Note</b> <sup>(1)</sup> After sending 2Eh command to deactivate the scrolling action, the ram data needs to be rewritten.		
0	2F	0	0	1	0	1	1	1	1	Activate scroll	Start scrolling that is configured by the scrolling setup commands :26h/27h/29h/2Ah with the following valid sequences:  Valid command sequence 1: 26h ;2Fh. Valid command sequence 2: 27h ;2Fh. Valid command sequence 3: 29h ;2Fh. Valid command sequence 4: 2Ah ;2Fh.  For example, if “26h; 2Ah; 2Fh.” commands are issued, the setting in the last scrolling setup command, i.e. 2Ah in this case, will be executed. In other words, setting in the last scrolling setup command overwrites the setting in the previous scrolling setup commands.	

2. Scrolling Command Table											
D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	A3	1	0	1	0	0	0	1	1	Set Vertical Scroll Area	A[5:0] : Set No. of rows in top fixed area. The No. of rows in top fixed area is referenced to the top of the GDDRAM (i.e. row 0). [RESET = 0]
0	A[5:0]	*	*	A <sub>5</sub>	A <sub>4</sub>	A <sub>3</sub>	A <sub>2</sub>	A <sub>1</sub>	A <sub>0</sub>		B[6:0] : Set No. of rows in scroll area. This is the number of rows to be used for vertical scrolling. The scroll area starts in the first row below the top fixed area. [RESET = 64]
0	B[6:0]	*	B <sub>6</sub>	B <sub>5</sub>	B <sub>4</sub>	B <sub>3</sub>	B <sub>2</sub>	B <sub>1</sub>	B <sub>0</sub>		
										<b>Note</b>	
										( <sup>1</sup> ) A[5:0]+B[6:0] <= MUX ratio	
										( <sup>2</sup> ) B[6:0] <= MUX ratio	
										( <sup>3a</sup> ) Vertical scrolling offset (E[5:0] in 29h/2Ah) < B[6:0]	
										( <sup>3b</sup> ) Set Display Start Line (X <sub>5</sub> X <sub>4</sub> X <sub>3</sub> X <sub>2</sub> X <sub>1</sub> X <sub>0</sub> of 40h~7Fh) < B[6:0]	
										( <sup>4</sup> ) The last row of the scroll area shifts to the first row of the scroll area.	
										( <sup>5</sup> ) For 64d MUX display	
										A[5:0] = 0, B[6:0]=64 : whole area scrolls	
										A[5:0]= 0, B[6:0] < 64 : top area scrolls	
										A[5:0] + B[6:0] < 64 : central area scrolls	
										A[5:0] + B[6:0] = 64 : bottom area scrolls	

### Note

(1) “\*” stands for “Don’t care”.

**Table 8-2 : Read Command Table**

<b>Bit Pattern</b>	<b>Command</b>	<b>Description</b>
D <sub>7</sub> D <sub>6</sub> D <sub>5</sub> D <sub>4</sub> D <sub>3</sub> D <sub>2</sub> D <sub>1</sub> D <sub>0</sub>	Status Register Read	D[7] : Reserved D[6] : “1” for display OFF / “0” for display ON D[5] : Reserved D[4] : Reserved D[3] : Reserved D[2] : Reserved D[1] : Reserved D[0] : Reserved

**Note**

<sup>(1)</sup> Patterns other than those given in the Command Table are prohibited to enter the chip as a command; as unexpected results can occur.

## 8.1 Data Read / Write

To read data from the GDDRAM, select HIGH for both the R/W# (WR#) pin and the D/C# pin for 6800-series parallel mode and select LOW for the E (RD#) pin and HIGH for the D/C# pin for 8080-series parallel mode. No data read is provided in serial mode operation.

In normal data read mode the GDDRAM column address pointer will be increased automatically by one after each data read.

Also, a dummy read is required before the first data read.

To write data to the GDDRAM, select LOW for the R/W# (WR#) pin and HIGH for the D/C# pin for both 6800-series parallel mode and 8080-series parallel mode. The serial interface mode is always in write mode. The GDDRAM column address pointer will be increased automatically by one after each data write.

**Table 8-3 : Address increment table (Automatic)**

<b>D/C#</b>	<b>R/W# (WR#)</b>	<b>Comment</b>	<b>Address Increment</b>
0	0	Write Command	No
0	1	Read Status	No
1	0	Write Data	Yes
1	1	Read Data	Yes

## 9 COMMAND DESCRIPTIONS

### 9.1 Fundamental Command

#### 9.1.1 Set Lower Column Start Address for Page Addressing Mode (00h~0Fh)

This command specifies the lower nibble of the 8-bit column start address for the display data RAM under Page Addressing Mode. The column address will be incremented by each data access. Please refer to Section Table 8-1 and Section 9.1.3 for details.

#### 9.1.2 Set Higher Column Start Address for Page Addressing Mode (10h~1Fh)

This command specifies the higher nibble of the 8-bit column start address for the display data RAM under Page Addressing Mode. The column address will be incremented by each data access. Please refer to Section Table 8-1 and Section 9.1.3 for details.

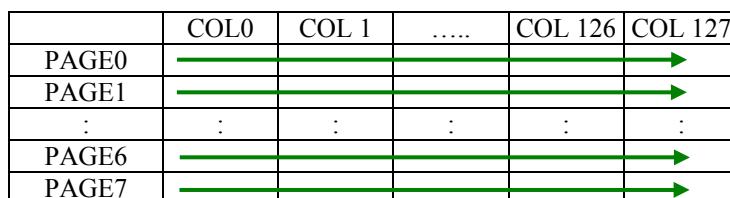
#### 9.1.3 Set Memory Addressing Mode (20h)

There are 3 different memory addressing mode in SSD1308: page addressing mode, horizontal addressing mode and vertical addressing mode. This command sets the way of memory addressing into one of the above three modes. In there, “COL” means the graphic display data RAM column.

##### Page addressing mode (A[1:0]=10xb)

In page addressing mode, after the display RAM is read/written, the column address pointer is increased automatically by 1. If the column address pointer reaches column end address, the column address pointer is reset to column start address and page address pointer is not changed. Users have to set the new page and column addresses in order to access the next page RAM content. The sequence of movement of the PAGE and column address point for page addressing mode is shown in Figure 9-1.

Figure 9-1 : Address Pointer Movement of Page addressing mode

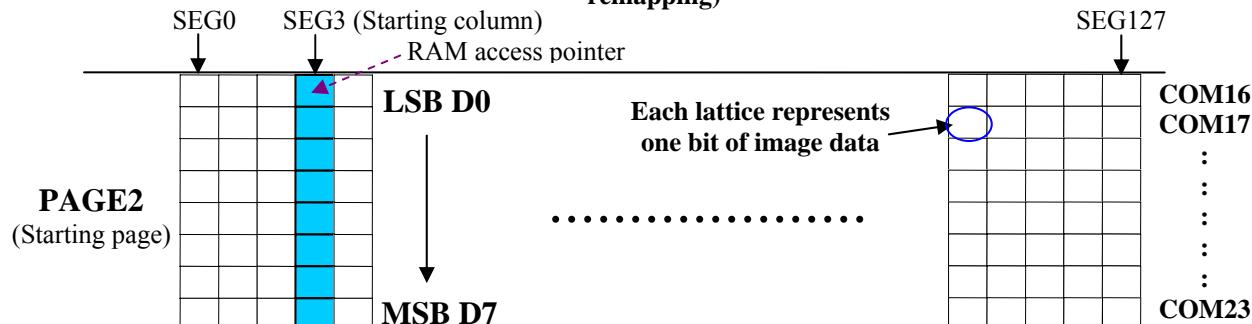


In normal display data RAM read or write and page addressing mode, the following steps are required to define the starting RAM access pointer location:

- Set the page start address of the target display location by command B0h to B7h.
- Set the lower start column address of pointer by command 00h~0Fh.
- Set the upper start column address of pointer by command 10h~1Fh.

For example, if the page address is set to B2h, lower column address is 03h and upper column address is 10h, then that means the starting column is SEG3 of PAGE2. The RAM access pointer is located as shown in Figure 9-2. The input data byte will be written into RAM position of column 3.

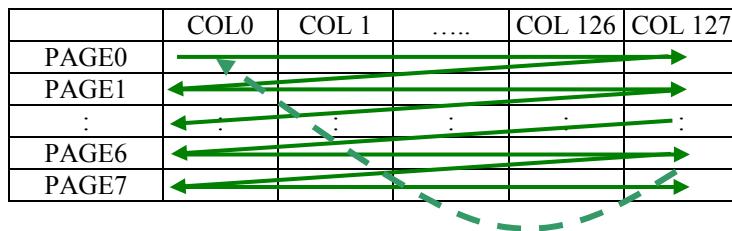
Figure 9-2 : Example of GDDRAM access pointer setting in Page Addressing Mode (No row and column-remapping)



#### Horizontal addressing mode (A[1:0]=00b)

In horizontal addressing mode, after the display RAM is read/written, the column address pointer is increased automatically by 1. If the column address pointer reaches column end address, the column address pointer is reset to column start address and page address pointer is increased by 1. The sequence of movement of the page and column address point for horizontal addressing mode is shown in Figure 9-3. When both column and page address pointers reach the end address, the pointers are reset to column start address and page start address (Dotted line in Figure 9-3.)

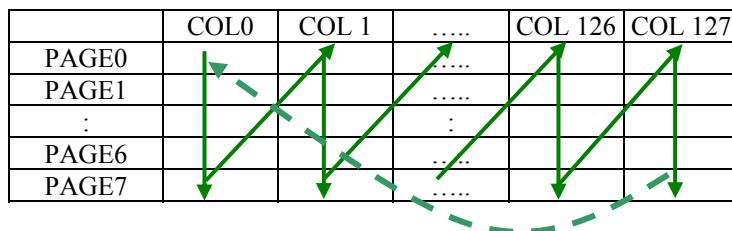
**Figure 9-3 : Address Pointer Movement of Horizontal addressing mode**



#### Vertical addressing mode: (A[1:0]=01b)

In vertical addressing mode, after the display RAM is read/written, the page address pointer is increased automatically by 1. If the page address pointer reaches the page end address, the page address pointer is reset to page start address and column address pointer is increased by 1. The sequence of movement of the page and column address point for vertical addressing mode is shown in Figure 9-4. When both column and page address pointers reach the end address, the pointers are reset to column start address and page start address (Dotted line in Figure 9-4.)

**Figure 9-4 : Address Pointer Movement of Vertical addressing mode**



In normal display data RAM read or write and horizontal / vertical addressing mode, the following steps are required to define the RAM access pointer location:

- Set the column start and end address of the target display location by command 21h.
- Set the page start and end address of the target display location by command 22h.

Example is shown in Figure 9-5.

#### **9.1.4 Set Column Address (21h)**

This triple byte command specifies column start address and end address of the display data RAM. This command also sets the column address pointer to column start address. This pointer is used to define the current read/write column address in graphic display data RAM. If horizontal address increment mode is enabled by command 20h, after finishing read/write one column data, it is incremented automatically to the next column address. Whenever the column address pointer finishes accessing the end column address, it is reset back to start column address and the row address is incremented to the next row.

### 9.1.5 Set Page Address (22h)

This triple byte command specifies page start address and end address of the display data RAM. This command also sets the page address pointer to page start address. This pointer is used to define the current read/write page address in graphic display data RAM. If vertical address increment mode is enabled by command 20h, after finishing read/write one page data, it is incremented automatically to the next page address. Whenever the page address pointer finishes accessing the end page address, it is reset back to start page address.

The figure below shows the way of column and page address pointer movement through the example: column start address is set to 2 and column end address is set to 125, page start address is set to 1 and page end address is set to 6; Horizontal address increment mode is enabled by command 20h. In this case, the graphic display data RAM column accessible range is from column 2 to column 125 and from page 1 to page 6 only. In addition, the column address pointer is set to 2 and page address pointer is set to 1. After finishing read/write one pixel of data, the column address is increased automatically by 1 to access the next RAM location for next read/write operation (*solid line* in Figure 9-5). Whenever the column address pointer finishes accessing the end column 125, it is reset back to column 2 and page address is automatically increased by 1 (*solid line* in Figure 9-5). While the end page 6 and end column 125 RAM location is accessed, the page address is reset back to 1 and the column address is reset back to 2 (*dotted line* in Figure 9-5).

**Figure 9-5 : Example of Column and Row Address Pointer Movement**

	Col 0	Col 1	Col 2	.....	.....	Col 125	Col 126	Col 127
PAGE0								
PAGE1								
:					:			
PAGE6								
PAGE7								

### 9.1.6 Set Display Start Line (40h~7Fh)

This command sets the Display Start Line register to determine starting address of display RAM, by selecting a value from 0 to 63. With value equal to 0, RAM row 0 is mapped to COM0. With value equal to 1, RAM row 1 is mapped to COM0 and so on.

Refer to Table 9-1 for more illustrations.

### 9.1.7 Set Contrast Control for BANK0 (81h)

This command sets the Contrast Setting of the display. The chip has 256 contrast steps from 00h to FFh. The segment output current increases as the contrast step value increases.

### 9.1.8 Set Segment Re-map (A0h/A1h)

This command changes the mapping between the display data column address and the segment driver. It allows flexibility in OLED module design. Please refer to Table 8-1.

This command only affects subsequent data input. Data already stored in GDDRAM will have no changes.

### **9.1.9 Entire Display ON (A4h/A5h)**

A4h command enable display outputs according to the GDDRAM contents.

If A5h command is issued, then by using A4h command, the display will resume to the GDDRAM contents.

In other words, A4h command resumes the display from entire display “ON” stage.

A5h command forces the entire display to be “ON”, regardless of the contents of the display data RAM.

### **9.1.10 Set Normal/Inverse Display (A6h/A7h)**

This command sets the display to be either normal or inverse. In normal display a RAM data of 1 indicates an “ON” pixel while in inverse display a RAM data of 0 indicates an “ON” pixel.

### **9.1.11 Set Multiplex Ratio (A8h)**

This command switches the default 63 multiplex mode to any multiplex ratio, ranging from 16 to 63. The output pads COM0~COM63 will be switched to the corresponding COM signal.

### **9.1.12 External or internal I<sub>REF</sub> Selection (ADh)**

This command selects the external I<sub>REF</sub> or internal I<sub>REF</sub>. Refer to Section 7.8 for details.

### **9.1.13 Set Display ON/OFF (AEh/AFh)**

These single byte commands are used to turn the OLED panel display ON or OFF.

When the display is ON, the selected circuits by Set Master Configuration command will be turned ON.

When the display is OFF, those circuits will be turned OFF and the segment and common output are in V<sub>SS</sub> state and high impedance state, respectively. These commands set the display to one of the two states:

- AEh : Display OFF
- AFh : Display ON

**Figure 9-6 :Transition between different modes**



### **9.1.14 Set Page Start Address for Page Addressing Mode (B0h~B7h)**

This command positions the page start address from 0 to 7 in GDDRAM under Page Addressing Mode. Please refer to Table 8-1 and Section 9.1.3 for details.

### **9.1.15 Set COM Output Scan Direction (C0h/C8h)**

This command sets the scan direction of the COM output, allowing layout flexibility in the OLED module design. Additionally, the display will show once this command is issued. For example, if this command is sent during normal display then the graphic display will be vertically flipped immediately. Please refer to Table 9-3 for details.

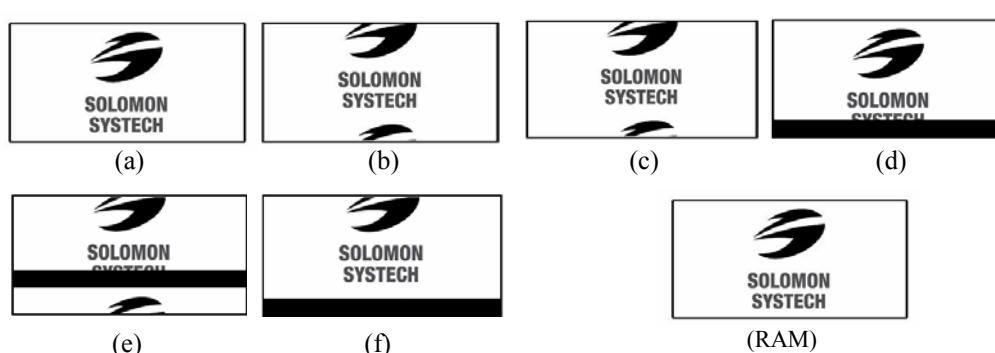
### **9.1.16 Set Display Offset (D3h)**

This is a double byte command. The second command specifies the mapping of the display start line to one of COM0~COM63 (assuming that COM0 is the display start line then the display start line register is equal to 0).

For example, to move the COM16 towards the COM0 direction by 16 lines the 6-bit data in the second byte should be given as 010000b. To move in the opposite direction by 16 lines the 6-bit data should be given by 64 – 16, so the second byte would be 100000b. The following two tables (Table 9-1, Table 9-2) show the example of setting the command C0h/C8h and D3h.

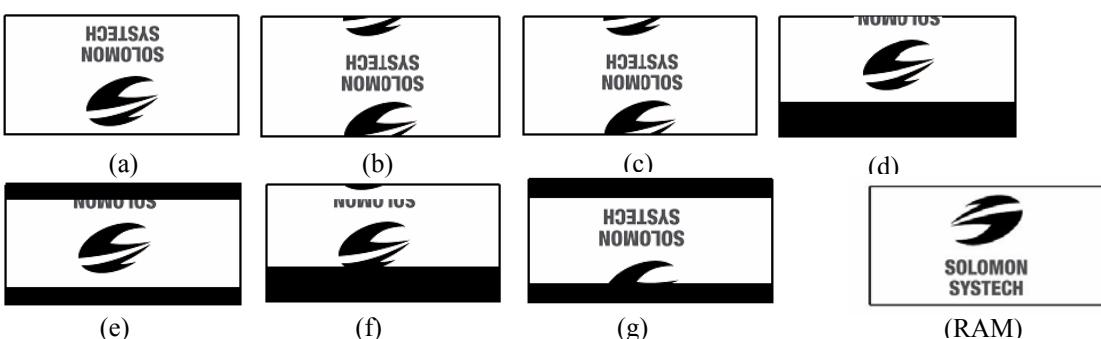
**Table 9-1 : Example of Set Display Offset and Display Start Line with no Remap**

Hardware pin name	Output												Set MUX ratio(A8h)	
	64		64		64		56		56		56			
	Normal													
COM0	Row0	RAM0	Row8	RAM8	Row0	RAM0	Row8	RAM8	Row0	RAM8	Row0	RAM8	COM Normal / Remapped (C0h / C8h)	
COM1	Row1	RAM1	Row9	RAM9	Row1	RAM9	Row9	RAM9	Row1	RAM9	Row1	RAM9	Display offset (D3h)	
COM2	Row2	RAM2	Row10	RAM10	Row2	RAM10	Row10	RAM10	Row2	RAM10	Row2	RAM10	Display start line (40h - 7Fh)	
COM3	Row3	RAM3	Row11	RAM11	Row3	RAM11	Row11	RAM11	Row3	RAM11	Row3	RAM11		
COM4	Row4	RAM4	Row12	RAM12	Row4	RAM12	Row12	RAM12	Row4	RAM12	Row4	RAM12		
COM5	Row5	RAM5	Row13	RAM13	Row5	RAM13	Row13	RAM13	Row5	RAM13	Row5	RAM13		
COM6	Row6	RAM6	Row14	RAM14	Row6	RAM14	Row14	RAM14	Row6	RAM14	Row6	RAM14		
COM7	Row7	RAM7	Row15	RAM15	Row7	RAM15	Row15	RAM15	Row7	RAM15	Row7	RAM15		
COM8	Row8	RAM8	Row16	RAM16	Row8	RAM16	Row8	RAM8	Row16	RAM16	Row8	RAM16		
COM9	Row9	RAM9	Row17	RAM17	Row9	RAM17	Row9	RAM9	Row17	RAM17	Row9	RAM17		
COM10	Row10	RAM10	Row18	RAM18	Row10	RAM18	Row10	RAM10	Row18	RAM18	Row10	RAM18		
COM11	Row11	RAM11	Row19	RAM19	Row11	RAM19	Row11	RAM11	Row19	RAM19	Row11	RAM19		
COM12	Row12	RAM12	Row20	RAM20	Row12	RAM20	Row12	RAM12	Row20	RAM20	Row12	RAM20		
COM13	Row13	RAM13	Row21	RAM21	Row13	RAM21	Row13	RAM13	Row21	RAM21	Row13	RAM21		
COM14	Row14	RAM14	Row22	RAM22	Row14	RAM22	Row14	RAM14	Row22	RAM22	Row14	RAM22		
COM15	Row15	RAM15	Row23	RAM23	Row15	RAM15	Row15	RAM15	Row23	RAM23	Row15	RAM23		
COM16	Row16	RAM16	Row24	RAM24	Row16	RAM16	Row16	RAM16	Row24	RAM24	Row16	RAM24		
COM17	Row17	RAM17	Row25	RAM25	Row17	RAM25	Row17	RAM17	Row25	RAM25	Row17	RAM25		
COM18	Row18	RAM18	Row26	RAM26	Row18	RAM26	Row18	RAM18	Row26	RAM26	Row18	RAM26		
COM19	Row19	RAM19	Row27	RAM27	Row19	RAM27	Row19	RAM19	Row27	RAM27	Row19	RAM27		
COM20	Row20	RAM20	Row28	RAM28	Row20	RAM28	Row20	RAM20	Row28	RAM28	Row20	RAM28		
COM21	Row21	RAM21	Row29	RAM29	Row21	RAM29	Row21	RAM21	Row29	RAM29	Row21	RAM29		
COM22	Row22	RAM22	Row30	RAM30	Row22	RAM30	Row22	RAM22	Row30	RAM30	Row22	RAM30		
COM23	Row23	RAM23	Row31	RAM31	Row23	RAM31	Row23	RAM23	Row31	RAM31	Row23	RAM31		
COM24	Row24	RAM24	Row32	RAM32	Row24	RAM32	Row24	RAM24	Row32	RAM32	Row24	RAM32		
COM25	Row25	RAM25	Row33	RAM33	Row25	RAM33	Row25	RAM25	Row33	RAM33	Row25	RAM33		
COM26	Row26	RAM26	Row34	RAM34	Row26	RAM34	Row26	RAM26	Row34	RAM34	Row26	RAM34		
COM27	Row27	RAM27	Row35	RAM35	Row27	RAM35	Row27	RAM27	Row35	RAM35	Row27	RAM35		
COM28	Row28	RAM28	Row36	RAM36	Row28	RAM36	Row28	RAM28	Row36	RAM36	Row28	RAM36		
COM29	Row29	RAM29	Row37	RAM37	Row29	RAM37	Row29	RAM29	Row37	RAM37	Row29	RAM37		
COM30	Row30	RAM30	Row38	RAM38	Row30	RAM38	Row30	RAM30	Row38	RAM38	Row30	RAM38		
COM31	Row31	RAM31	Row39	RAM39	Row31	RAM39	Row31	RAM31	Row39	RAM39	Row31	RAM39		
COM32	Row32	RAM32	Row40	RAM40	Row32	RAM40	Row32	RAM32	Row40	RAM40	Row32	RAM40		
COM33	Row33	RAM33	Row41	RAM41	Row33	RAM41	Row33	RAM33	Row41	RAM41	Row33	RAM41		
COM34	Row34	RAM34	Row42	RAM42	Row34	RAM42	Row34	RAM34	Row42	RAM42	Row34	RAM42		
COM35	Row35	RAM35	Row43	RAM43	Row35	RAM43	Row35	RAM35	Row43	RAM43	Row35	RAM43		
COM36	Row36	RAM36	Row44	RAM44	Row36	RAM44	Row36	RAM36	Row44	RAM44	Row36	RAM44		
COM37	Row37	RAM37	Row45	RAM45	Row37	RAM45	Row37	RAM37	Row45	RAM45	Row37	RAM45		
COM38	Row38	RAM38	Row46	RAM46	Row38	RAM46	Row38	RAM38	Row46	RAM46	Row38	RAM46		
COM39	Row39	RAM39	Row47	RAM47	Row39	RAM47	Row39	RAM39	Row47	RAM47	Row39	RAM47		
COM40	Row40	RAM40	Row48	RAM48	Row40	RAM48	Row40	RAM40	Row48	RAM48	Row40	RAM48		
COM41	Row41	RAM41	Row49	RAM49	Row41	RAM49	Row41	RAM41	Row49	RAM49	Row41	RAM49		
COM42	Row42	RAM42	Row50	RAM50	Row42	RAM50	Row42	RAM42	Row50	RAM50	Row42	RAM50		
COM43	Row43	RAM43	Row51	RAM51	Row43	RAM51	Row43	RAM43	Row51	RAM51	Row43	RAM51		
COM44	Row44	RAM44	Row52	RAM52	Row44	RAM52	Row44	RAM44	Row52	RAM52	Row44	RAM52		
COM45	Row45	RAM45	Row53	RAM53	Row45	RAM53	Row45	RAM45	Row53	RAM53	Row45	RAM53		
COM46	Row46	RAM46	Row54	RAM54	Row46	RAM54	Row46	RAM46	Row54	RAM54	Row46	RAM54		
COM47	Row47	RAM47	Row55	RAM55	Row47	RAM55	Row47	RAM47	Row55	RAM55	Row47	RAM55		
COM48	Row48	RAM48	Row56	RAM56	Row48	RAM56	Row48	RAM48	-	-	Row48	RAM56		
COM49	Row49	RAM49	Row57	RAM57	Row49	RAM57	Row49	RAM49	-	-	Row49	RAM57		
COM50	Row50	RAM50	Row58	RAM58	Row50	RAM58	Row50	RAM50	-	-	Row50	RAM58		
COM51	Row51	RAM51	Row59	RAM59	Row51	RAM59	Row51	RAM51	-	-	Row51	RAM59		
COM52	Row52	RAM52	Row60	RAM60	Row52	RAM60	Row52	RAM52	-	-	Row52	RAM60		
COM53	Row53	RAM53	Row61	RAM61	Row53	RAM61	Row53	RAM53	-	-	Row53	RAM61		
COM54	Row54	RAM54	Row62	RAM62	Row54	RAM62	Row54	RAM54	-	-	Row54	RAM62		
COM55	Row55	RAM55	Row63	RAM63	Row55	RAM63	Row55	RAM55	-	-	Row55	RAM63		
COM56	Row56	RAM56	Row0	RAM0	Row56	RAM0	-	-	Row0	RAM0	-	-		
COM57	Row57	RAM57	Row1	RAM1	Row57	RAM1	-	-	Row1	RAM1	-	-		
COM58	Row58	RAM58	Row2	RAM2	Row58	RAM2	-	-	Row2	RAM2	-	-		
COM59	Row59	RAM59	Row3	RAM3	Row59	RAM3	-	-	Row3	RAM3	-	-		
COM60	Row60	RAM60	Row4	RAM4	Row60	RAM4	-	-	Row4	RAM4	-	-		
COM61	Row61	RAM61	Row5	RAM5	Row61	RAM5	-	-	Row5	RAM5	-	-		
COM62	Row62	RAM62	Row6	RAM6	Row62	RAM6	-	-	Row6	RAM6	-	-		
COM63	Row63	RAM63	Row7	RAM7	Row63	RAM7	-	-	Row7	RAM7	-	-		



**Table 9-2 :Example of Set Display Offset and Display Start Line with Remap**

Hardware pin name	Output							Set MUX ratio(A8h) COM Normal / Remapped (C0h / C8h) Display offset (D3h) Display start line (40h - 7Fh)
	64		64		48		48	
	Remap	Remap	Remap	Remap	Remap	Remap	Remap	
	0	8	0	0	8	0	8	
	0	0	8	0	0	8	16	
COM0	Row63	RAM63	Row7	RAM7	Row63	RAM7	Row47	RAM65
COM1	Row62	RAM62	Row6	RAM6	Row62	RAM6	Row46	RAM54
COM2	Row61	RAM61	Row5	RAM5	Row61	RAM5	Row45	RAM53
COM3	Row60	RAM60	Row4	RAM4	Row60	RAM4	Row44	RAM52
COM4	Row59	RAM59	Row3	RAM3	Row59	RAM3	Row43	RAM51
COM5	Row68	RAM68	Row2	RAM2	Row68	RAM2	Row42	RAM50
COM6	Row57	RAM57	Row1	RAM1	Row57	RAM1	Row41	RAM49
COM7	Row56	RAM56	Row0	RAM0	Row56	RAM0	Row40	RAM48
COM8	Row63	RAM63	Row63	RAM63	Row55	RAM55	Row47 / RAM47	Row47 / RAM63
COM9	Row64	RAM64	Row62	RAM62	Row54	RAM52	Row46 / RAM46	Row46 / RAM62
COM10	Row63	RAM53	Row61	RAM61	Row53	RAM61	Row37 / RAM45	Row45 / RAM61
COM11	Row52	RAM52	Row60	RAM60	Row52	RAM60	Row36 / RAM44	Row44 / RAM60
COM12	Row61	RAM61	Row59	RAM59	Row51	RAM59	Row35 / RAM43	Row43 / RAM59
COM13	Row50	RAM50	Row58	RAM58	Row50	RAM58	Row34 / RAM42	Row42 / RAM58
COM14	Row49	RAM49	Row57	RAM57	Row49	RAM57	Row33 / RAM41	Row41 / RAM57
COM15	Row48	RAM48	Row56	RAM56	Row48	RAM56	Row32 / RAM40	Row40 / RAM56
COM16	Row47	RAM47	Row55	RAM55	Row47	RAM55	Row31 / RAM39	Row39 / RAM55
COM17	Row46	RAM46	Row54	RAM54	Row46	RAM54	Row30 / RAM38	Row38 / RAM54
COM18	Row45	RAM45	Row53	RAM53	Row45	RAM53	Row29 / RAM37	Row37 / RAM53
COM19	Row44	RAM44	Row52	RAM52	Row44	RAM52	Row28 / RAM36	Row36 / RAM52
COM20	Row43	RAM43	Row51	RAM51	Row43	RAM51	Row27 / RAM35	Row35 / RAM51
COM21	Row42	RAM42	Row60	RAM60	Row42	RAM60	Row26 / RAM34	Row34 / RAM50
COM22	Row41	RAM41	Row49	RAM49	Row41	RAM49	Row25 / RAM33	Row33 / RAM49
COM23	Row40	RAM40	Row48	RAM48	Row40	RAM48	Row24 / RAM32	Row32 / RAM48
COM24	Row39	RAM39	Row47	RAM47	Row39	RAM47	Row23 / RAM31	Row31 / RAM47
COM25	Row38	RAM38	Row46	RAM46	Row38	RAM46	Row22 / RAM30	Row30 / RAM46
COM26	Row37	RAM37	Row45	RAM45	Row37	RAM45	Row21 / RAM29	Row29 / RAM45
COM27	Row36	RAM36	Row44	RAM44	Row36	RAM44	Row20 / RAM28	Row28 / RAM44
COM28	Row35	RAM35	Row43	RAM43	Row35	RAM43	Row19 / RAM19	Row19 / RAM43
COM29	Row34	RAM34	Row42	RAM42	Row34	RAM42	Row18 / RAM18	Row18 / RAM42
COM30	Row33	RAM33	Row41	RAM41	Row33	RAM41	Row17 / RAM17	Row17 / RAM41
COM31	Row32	RAM32	Row40	RAM40	Row32	RAM40	Row16 / RAM16	Row16 / RAM40
COM32	Row31	RAM31	Row39	RAM39	Row31	RAM39	Row15 / RAM15	Row15 / RAM39
COM33	Row30	RAM30	Row38	RAM38	Row30	RAM38	Row14 / RAM22	Row22 / RAM38
COM34	Row29	RAM29	Row37	RAM37	Row29	RAM37	Row13 / RAM13	Row21 / RAM37
COM35	Row28	RAM28	Row36	RAM36	Row28	RAM36	Row12 / RAM12	Row20 / RAM36
COM36	Row27	RAM27	Row35	RAM35	Row27	RAM35	Row11 / RAM11	Row19 / RAM35
COM37	Row26	RAM26	Row34	RAM34	Row26	RAM34	Row10 / RAM10	Row18 / RAM34
COM38	Row25	RAM25	Row33	RAM33	Row25	RAM33	Row9 / RAM9	Row17 / RAM33
COM39	Row24	RAM24	Row32	RAM32	Row24	RAM32	Row8 / RAM8	Row16 / RAM32
COM40	Row23	RAM23	Row31	RAM31	Row23	RAM31	Row7 / RAM7	Row15 / RAM31
COM41	Row22	RAM22	Row30	RAM30	Row22	RAM30	Row6 / RAM6	Row14 / RAM30
COM42	Row21	RAM21	Row29	RAM29	Row21	RAM29	Row5 / RAM5	Row13 / RAM29
COM43	Row20	RAM20	Row28	RAM28	Row20	RAM28	Row4 / RAM4	Row12 / RAM28
COM44	Row19	RAM19	Row27	RAM27	Row19	RAM27	Row3 / RAM3	Row11 / RAM27
COM45	Row18	RAM18	Row26	RAM26	Row18	RAM26	Row2 / RAM2	Row10 / RAM26
COM46	Row17	RAM17	Row25	RAM25	Row17	RAM25	Row1 / RAM1	Row9 / RAM25
COM47	Row16	RAM16	Row24	RAM24	Row16	RAM24	Row0 / RAM0	Row8 / RAM24
COM48	Row15	RAM15	Row23	RAM23	Row15	RAM23	- / RAM/	Row/ / RAM23
COM49	Row14	RAM14	Row22	RAM22	Row14	RAM22	Row6 / RAM6	Row6 / RAM22
COM50	Row13	RAM13	Row21	RAM21	Row13	RAM21	Row5 / RAM5	Row5 / RAM21
COM51	Row12	RAM12	Row20	RAM20	Row12	RAM20	Row4 / RAM4	Row4 / RAM20
COM52	Row11	RAM11	Row19	RAM19	Row11	RAM19	Row3 / RAM3	Row3 / RAM19
COM53	Row10	RAM10	Row18	RAM18	Row10	RAM18	Row2 / RAM2	Row2 / RAM18
COM54	Row9	RAM9	Row17	RAM17	Row9	RAM17	Row1 / RAM1	Row1 / RAM17
COM55	Row8	RAM8	Row16	RAM16	Row8	RAM16	Row0 / RAM0	Row0 / RAM16
COM56	Row7	RAM7	Row15	RAM15	Row7	RAM15	- / RAM-	- / -
COM57	Row6	RAM6	Row14	RAM14	Row6	RAM14	- / RAM-	- / -
COM58	Row5	RAM5	Row13	RAM13	Row5	RAM13	- / RAM-	- / -
COM59	Row4	RAM4	Row12	RAM12	Row4	RAM12	- / RAM-	- / -
COM60	Row3	RAM3	Row11	RAM11	Row3	RAM11	- / RAM-	- / -
COM61	Row2	RAM2	Row10	RAM10	Row2	RAM10	- / RAM-	- / -
COM62	Row1	RAM1	Row9	RAM9	Row1	RAM9	- / RAM-	- / -
COM63	Row0	RAM0	Row8	RAM8	Row0	RAM8	- / RAM-	- / -



### 9.1.17 Set Display Clock Divide Ratio/ Oscillator Frequency (D5h)

This command consists of two functions:

- Display Clock Divide Ratio (D)(A[3:0])

Set the divide ratio to generate DCLK (Display Clock) from CLK. The divide ratio is from 1 to 16, with reset value = 1. Please refer to section 7.3 for the details relationship of DCLK and CLK.

- Oscillator Frequency (A[7:4])

Program the oscillator frequency Fosc that is the source of CLK if CLS pin is pulled high. The 4-bit value results in 16 different frequency settings available as shown below. The default setting is 1000b.

### 9.1.18 Set Pre-charge Period (D9h)

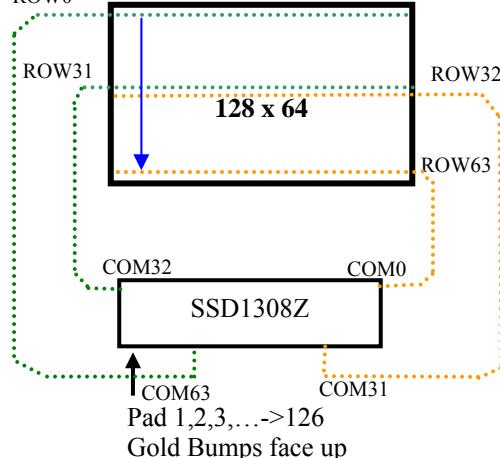
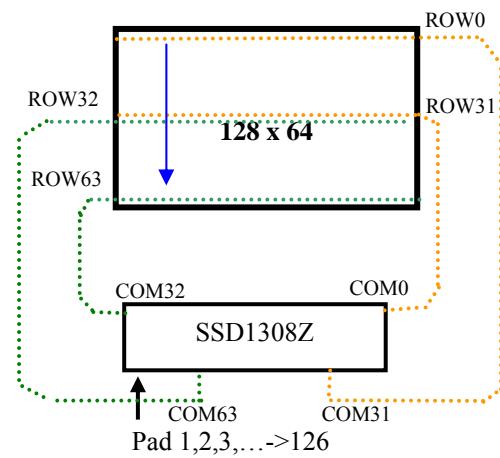
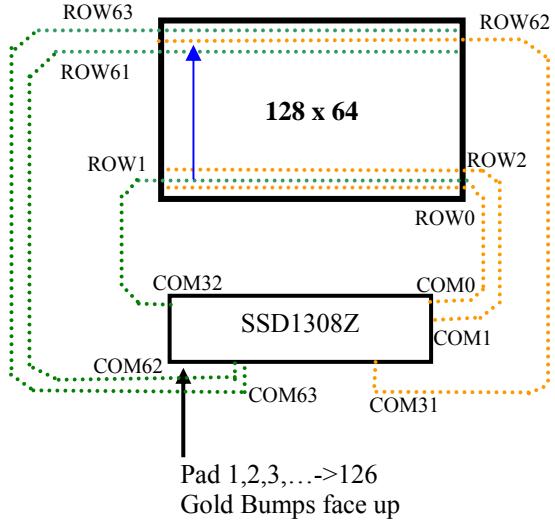
This command is used to set the duration of the pre-charge period. The interval is counted in number of DCLK, where RESET equals 2 DCLKs.

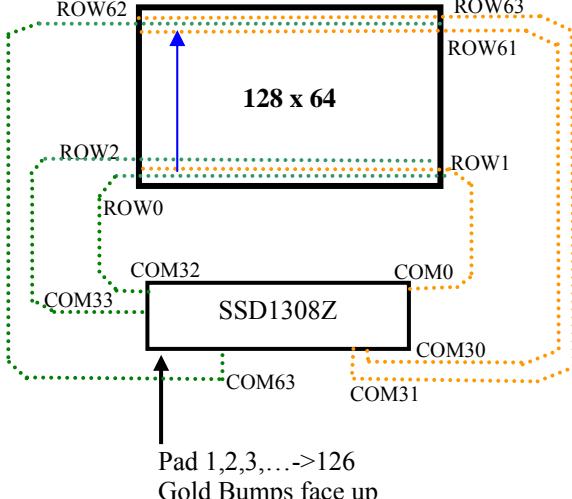
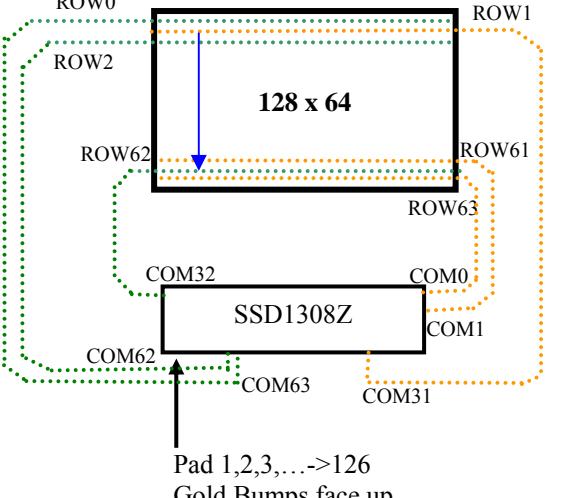
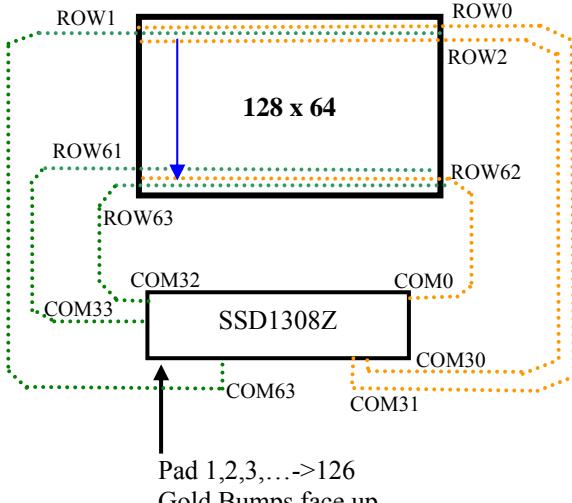
### 9.1.19 Set COM Pins Hardware Configuration (DAh)

This command sets the COM signals pin configuration to match the OLED panel hardware layout. The table below shows the COM pin configuration under different conditions (for MUX ratio =64):

**Table 9-3 : COM Pins Hardware Configuration**

Conditions	COM pins Configurations
1 Sequential COM pin configuration (DAh A[4] =0) COM output Scan direction: from COM0 to COM63 (C0h) Disable COM Left/Right remap (DAh A[5] =0)	
2 Sequential COM pin configuration (DAh A[4] =0) COM output Scan direction: from COM0 to COM63 (C0h) Enable COM Left/Right remap (DAh A[5] =1)	

Conditions	COM pins Configurations
3 Sequential COM pin configuration (DAh A[4]=0) COM output Scan direction: from COM63 to COM0 (C8h) Disable COM Left/Right remap (DAh A[5]=0)	 <p>ROW0 ROW31 ROW32 ROW63 <b>128 x 64</b> COM32      COM0 COM63      COM31 Pad 1,2,3,...&gt;126 Gold Bumps face up</p>
4 Sequential COM pin configuration (DAh A[4]=0) COM output Scan direction: from COM63 to COM0 (C8h) Enable COM Left/Right remap (DAh A[5]=1)	 <p>ROW0 ROW32 ROW63 ROW31 <b>128 x 64</b> COM32      COM0 COM63      COM31 Pad 1,2,3,...&gt;126 Gold Bumps face up</p>
5 Alternative COM pin configuration (DAh A[4]=1) COM output Scan direction: from COM0 to COM63 (C0h) Disable COM Left/Right remap (DAh A[5]=0)	 <p>ROW63 ROW61 ROW1 ROW0 ROW2 <b>128 x 64</b> COM32      COM0 COM1 COM62      COM63      COM31 Pad 1,2,3,...&gt;126 Gold Bumps face up</p>

Conditions	COM pins Configurations
6 Alternative COM pin configuration (DAh A[4]=1) COM output Scan direction: from COM0 to COM63 (C0h) Enable COM Left/Right remap (DAh A[5]=1)	 <p>128 x 64 SSD1308Z Pad 1,2,3,...&gt;126 Gold Bumps face up</p>
7 Alternative COM pin configuration (DAh A[4]=1) COM output Scan direction: from COM63 to COM0(C8h) Disable COM Left/Right remap (DAh A[5]=0)	 <p>128 x 64 SSD1308Z Pad 1,2,3,...&gt;126 Gold Bumps face up</p>
8 Alternative COM pin configuration (DAh A[4]=1) COM output Scan direction: from COM63 to COM0(C8h) Enable COM Left/Right remap (DAh A[5]=1)	 <p>128 x 64 SSD1308Z Pad 1,2,3,...&gt;126 Gold Bumps face up</p>

### **9.1.20 Set V<sub>COMH</sub> Deselect Level (DBh)**

This command adjusts the V<sub>COMH</sub> regulator output.

### **9.1.21 NOP (E3h)**

No Operation Command

### **9.1.22 Status register Read**

This command is issued by setting D/C# ON LOW during a data read (See Figure 12-1 to Figure 12-2 for parallel interface waveform). It allows the MCU to monitor the internal status of the chip. No status read is provided for serial mode.

## 9.2 Graphic Acceleration Command

### 9.2.1 Horizontal Scroll Setup (26h/27h)

This command consists of consecutive bytes to set up the horizontal scroll parameters and determines the scrolling start page, end page and scrolling speed.

Before issuing this command the horizontal scroll must be deactivated (2Eh). Otherwise, RAM content may be corrupted.

The SSD1308 horizontal scroll is designed for 128 columns scrolling. The following two figures (Figure 9-7, Figure 9-8, Figure 9-9) show the examples of using the horizontal scroll:

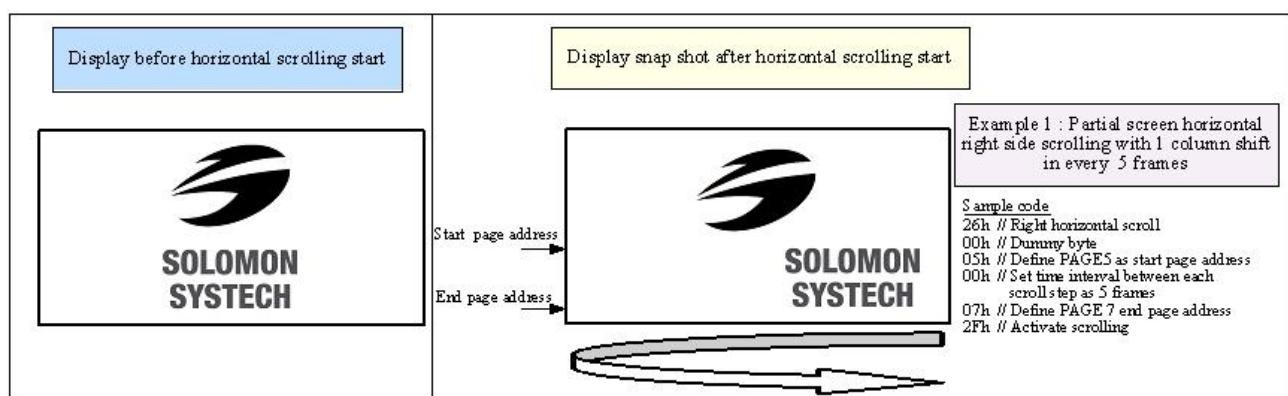
**Figure 9-7 : Horizontal scroll example: Scroll RIGHT by 1 column**

Original Setting	SEG0	SEG0	SEG1	SEG2	SEG3	SEG4	SEG5	SEG6	SEG7	SEG8	SEG9	SEG10	SEG11	SEG12	SEG13	SEG14	SEG15	SEG16	SEG17
After one scroll step	SEG127	SEG0	SEG1	SEG2	SEG3	SEG4	SEG5	SEG6	SEG7	SEG8	SEG9	SEG10	SEG11	SEG12	SEG13	SEG14	SEG15	SEG16	SEG17

**Figure 9-8 : Horizontal scroll example: Scroll LEFT by 1 column**

Original Setting	SEG0	SEG1	SEG2	SEG3	SEG4	SEG5	SEG6	SEG7	SEG8	SEG9	SEG10	SEG11	SEG12	SEG13	SEG14	SEG15	SEG16	SEG17
After one scroll step	SEG1	SEG2	SEG3	SEG4	SEG5	SEG6	SEG7	SEG8	SEG9	SEG10	SEG11	SEG12	SEG13	SEG14	SEG15	SEG16	SEG17	SEG0

**Figure 9-9 : Horizontal scrolling setup example**



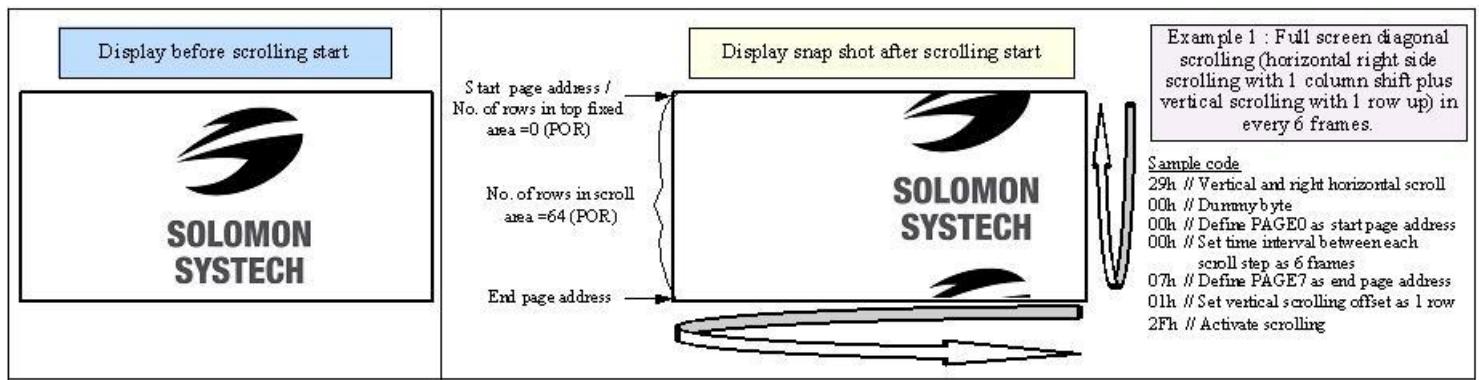
### 9.2.2 Continuous Vertical and Horizontal Scroll Setup (29h/2Ah)

This command consists of 6 consecutive bytes to set up the continuous vertical scroll parameters and determines the scrolling start page, end page, scrolling speed and vertical scrolling offset.

The bytes B[2:0], C[2:0] and D[2:0] of command 29h/2Ah are for the setting of the continuous horizontal scrolling. The byte E[5:0] is for the setting of the continuous vertical scrolling offset. All these bytes together are for the setting of continuous diagonal (horizontal + vertical) scrolling. If the vertical scrolling offset byte E[5:0] is set to zero, then only horizontal scrolling is performed (like command 26/27h).

Before issuing this command the scroll must be deactivated (2Eh). Otherwise, RAM content may be corrupted. The following figure (Figure 9-10 ) show the example of using the continuous vertical and horizontal scroll:

**Figure 9-10 : Continuous Vertical and Horizontal scrolling setup example**



### 9.2.3 Deactivate Scroll (2Eh)

This command stops the motion of scrolling. After sending 2Eh command to deactivate the scrolling action, the ram data needs to be rewritten.

### 9.2.4 Activate Scroll (2Fh)

This command starts the motion of scrolling and should only be issued after the scroll setup parameters have been defined by the scrolling setup commands :26h/27h/29h/2Ah . The setting in the last scrolling setup command overwrites the setting in the previous scrolling setup commands.

The following actions are prohibited after the scrolling is activated

1. RAM access (Data write or read)
2. Changing the horizontal scroll setup parameters

### 9.2.5 Set Vertical Scroll Area(A3h)

This command consists of 3 consecutive bytes to set up the vertical scroll area. For the continuous vertical scroll function (command 29/2Ah), the number of rows that in vertical scrolling can be set smaller or equal to the MUX ratio.

## 10 MAXIMUM RATINGS

Table 10-1 : Maximum Ratings (Voltage Referenced to VSS)

Symbol	Parameter	Value	Unit
$V_{DD}$	Supply Voltage	-0.3 to +4	V
$V_{CC}$		0 to 16	V
$V_{SEG}$	SEG output voltage	0 to $V_{CC}$	V
$V_{COM}$	COM output voltage	0 to 0.9* $V_{CC}$	V
$V_{in}$	Input voltage	$V_{SS}-0.3$ to $V_{DD}+0.3$	V
$T_A$	Operating Temperature	-40 to +85	°C
$T_{stg}$	Storage Temperature Range	-65 to +150	°C

Maximum ratings are those values beyond which damages to the device may occur. Functional operation should be restricted to the limits in the Electrical Characteristics tables or Pin Description section

This device may be light sensitive. Caution should be taken to avoid exposure of this device to any light source during normal operation. This device is not radiation protected.

## 11 DC CHARACTERISTICS

**Condition (Unless otherwise specified):**

Voltage referenced to V<sub>SS</sub>

V<sub>DD</sub> = 1.65 to 3.3V

T<sub>A</sub> = 25°C

**Table 11-1 : DC Characteristics**

Symbol	Parameter	Test Condition	Min	Typ	Max	Unit
V <sub>CC</sub>	Operating Voltage	-	7	-	15	V
V <sub>DD</sub>	Logic Supply Voltage	-	1.65	-	3.3	V
V <sub>OH</sub>	High Logic Output Level	I <sub>OUT</sub> = 100uA, 3.3MHz	0.9 x V <sub>DD</sub>	-	-	V
V <sub>OL</sub>	Low Logic Output Level	I <sub>OUT</sub> = 100uA, 3.3MHz	-	-	0.1 x V <sub>DD</sub>	V
V <sub>IH</sub>	High Logic Input Level	-	0.8 x V <sub>DD</sub>	-	-	V
V <sub>IL</sub>	Low Logic Input Level	-	-	-	0.2 x V <sub>DD</sub>	V
I <sub>CC, SLEEP</sub>	I <sub>CC</sub> , Sleep mode Current	V <sub>DD</sub> = 1.65V~3.3V, V <sub>CC</sub> = 7V~15V Display OFF, No panel attached	-	-	10	uA
I <sub>DD, SLEEP</sub>	I <sub>DD</sub> , Sleep mode Current	V <sub>DD</sub> = 1.65V~3.3V, V <sub>CC</sub> = 7V~15V Display OFF, No panel attached	-	-	10	uA
I <sub>CC</sub>	V <sub>CC</sub> Supply Current V <sub>DD</sub> = 2.8V, V <sub>CC</sub> = 12V, I <sub>REF</sub> = 19uA No loading, Display ON, All ON	Contrast = FFh	-	600	950	uA
I <sub>DD</sub>	V <sub>DD</sub> Supply Current V <sub>DD</sub> = 2.8V, V <sub>CC</sub> = 12V, I <sub>REF</sub> = 19uA No loading, Display ON, All ON		-	50	150	uA
I <sub>SEG</sub>	Segment Output Current V <sub>DD</sub> =2.8V, V <sub>CC</sub> =12V, I <sub>REF</sub> =19uA, Display ON.	Contrast=FFh Contrast=AFh Contrast=3Fh	-	150	-	uA
Dev	Segment output current uniformity	Dev = (I <sub>SEG</sub> - I <sub>MID</sub> )/I <sub>MID</sub> I <sub>MID</sub> = (I <sub>MAX</sub> + I <sub>MIN</sub> )/2 I <sub>SEG</sub> [0:131] = Segment current at contrast = FFh	-3	-	+3	
Adj. Dev	Adjacent pin output current uniformity (contrast = FF)	Adj Dev = (I[n]-I[n+1]) / (I[n]+I[n+1])	-2	-	+2	

## 12 AC CHARACTERISTICS

### Conditions:

Voltage referenced to V<sub>SS</sub>

V<sub>DD</sub>=1.65 to 3.3V

T<sub>A</sub> = 25°C

**Table 12-1 : AC Characteristics**

Symbol	Parameter	Test Condition	Min	Typ	Max	Unit
FOSC <sup>(1)</sup>	Oscillation Frequency of Display Timing Generator	V <sub>DD</sub> = 2.8V	333	370	407	kHz
FFRM	Frame Frequency for 64 MUX Mode	128x64 Graphic Display Mode, Display ON, Internal Oscillator Enabled	-	FOSC x 1/(DxKx64) <sup>(2)</sup>	-	Hz
RES#	Reset low pulse width		3	-	-	us

### Note

<sup>(1)</sup> Fosc stands for the frequency value of the internal oscillator and the value is measured when command D5h A[7:4] is in default value.

<sup>(2)</sup> D: divide ratio (default value = 1)

K: number of display clocks (default value = 54)

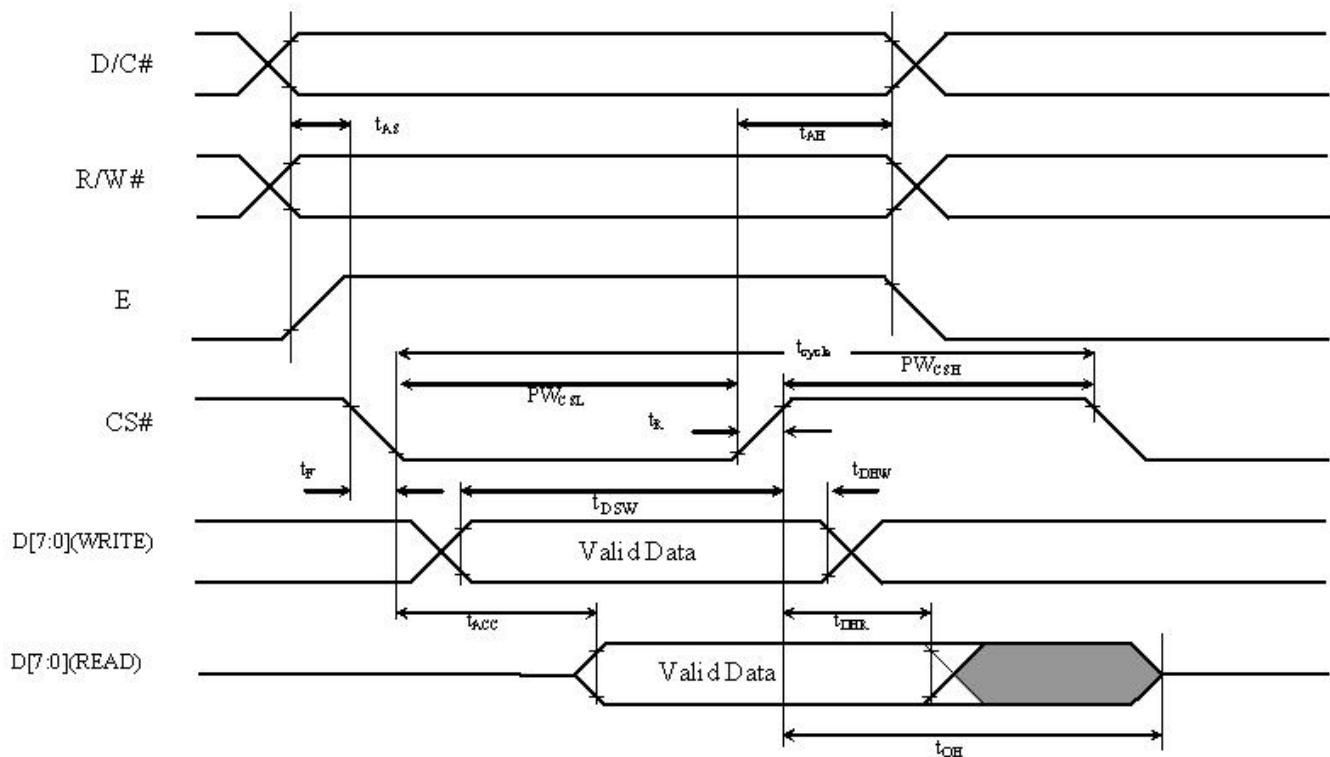
Please refer to Table 8-1 (Set Display Clock Divide Ratio/Oscillator Frequency, D5h) for detailed description

**Table 12-2 : 6800-Series MCU Parallel Interface Timing Characteristics**

( $V_{DD} - V_{SS} = 1.65V$  to  $3.3V$ ,  $T_A = 25^\circ C$ )

Symbol	Parameter	Min	Typ	Max	Unit
$t_{cycle}$	Clock Cycle Time	300	-	-	ns
$t_{AS}$	Address Setup Time	0	-	-	ns
$t_{AH}$	Address Hold Time	0	-	-	ns
$t_{DSW}$	Write Data Setup Time	40	-	-	ns
$t_{DHW}$	Write Data Hold Time	7	-	-	ns
$t_{DHR}$	Read Data Hold Time	20	-	-	ns
$t_{OH}$	Output Disable Time	-	-	70	ns
$t_{ACC}$	Access Time	-	-	140	ns
$PW_{CSL}$	Chip Select Low Pulse Width (read)	120	-	-	ns
	Chip Select Low Pulse Width (write)	60	-	-	ns
$PW_{CSH}$	Chip Select High Pulse Width (read)	60	-	-	ns
	Chip Select High Pulse Width (write)	60	-	-	ns
$t_R$	Rise Time	-	-	40	ns
$t_F$	Fall Time	-	-	40	ns

**Figure 12-1 : 6800-series MCU parallel interface characteristics**



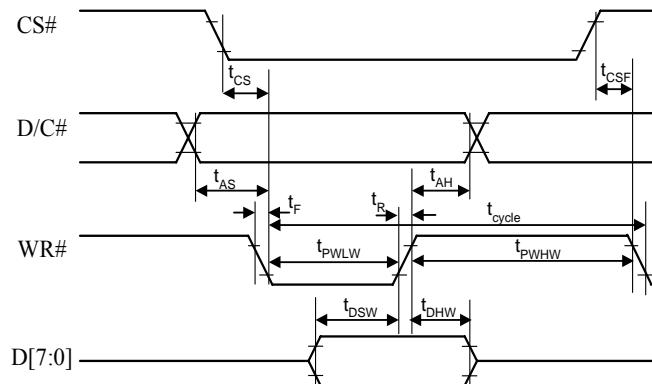
**Table 12-3 : 8080-Series MCU Parallel Interface Timing Characteristics**

( $V_{DD} - V_{SS} = 1.65V$  to  $3.3V$ ,  $T_A = 25^\circ C$ )

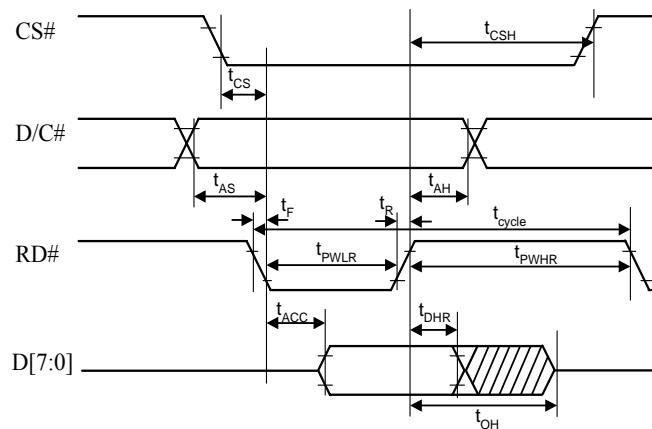
Symbol	Parameter	Min	Typ	Max	Unit
$t_{cycle}$	Clock Cycle Time	300	-	-	ns
$t_{AS}$	Address Setup Time	10	-	-	ns
$t_{AH}$	Address Hold Time	0	-	-	ns
$t_{DSW}$	Write Data Setup Time	40	-	-	ns
$t_{DHW}$	Write Data Hold Time	7	-	-	ns
$t_{DHR}$	Read Data Hold Time	20	-	-	ns
$t_{OH}$	Output Disable Time	-	-	70	ns
$t_{ACC}$	Access Time	-	-	140	ns
$t_{PWLR}$	Read Low Time	120	-	-	ns
$t_{PWLW}$	Write Low Time	60	-	-	ns
$t_{PWHR}$	Read High Time	60	-	-	ns
$t_{PWHW}$	Write High Time	60	-	-	ns
$t_R$	Rise Time	-	-	40	ns
$t_F$	Fall Time	-	-	40	ns
$t_{CS}$	Chip select setup time	0	-	-	ns
$t_{CSH}$	Chip select hold time to read signal	0	-	-	ns
$t_{CSF}$	Chip select hold time	20	-	-	ns

**Figure 12-2 : 8080-series parallel interface characteristics**

Write Cycle



Read cycle

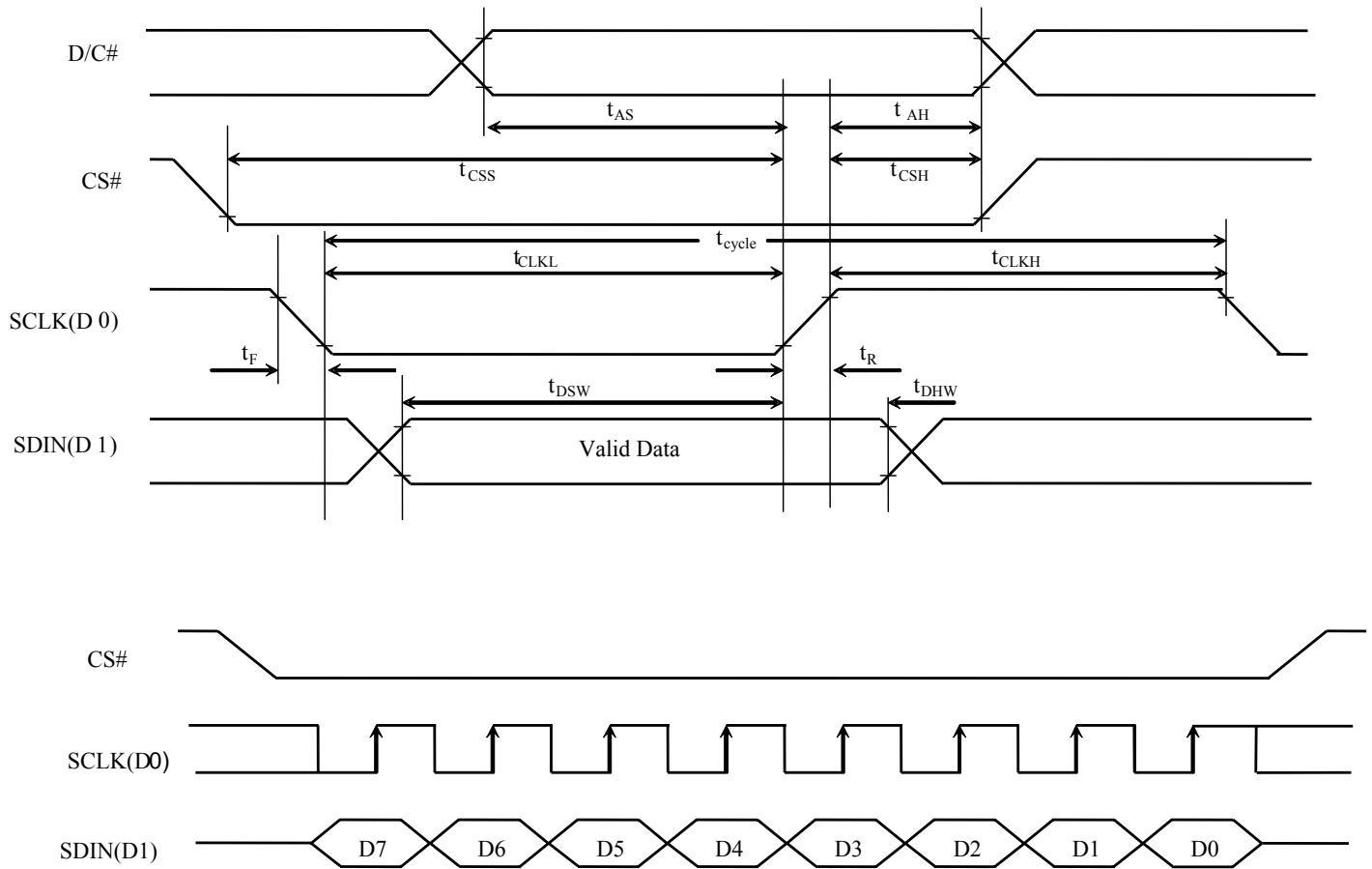


**Table 12-4 : 4-wire Serial Interface Timing Characteristics**

( $V_{DD} - V_{SS} = 1.65V$  to  $3.3V$ ,  $T_A = 25^\circ C$ )

Symbol	Parameter	Min	Typ	Max	Unit
$t_{cycle}$	Clock Cycle Time	100	-	-	ns
$t_{AS}$	Address Setup Time	15	-	-	ns
$t_{AH}$	Address Hold Time	15	-	-	ns
$t_{CSS}$	Chip Select Setup Time	20	-	-	ns
$t_{CSH}$	Chip Select Hold Time	10	-	-	ns
$t_{DSW}$	Write Data Setup Time	15	-	-	ns
$t_{DHW}$	Write Data Hold Time	15	-	-	ns
$t_{CLKL}$	Clock Low Time	20	-	-	ns
$t_{CLKH}$	Clock High Time	20	-	-	ns
$t_R$	Rise Time	-	-	40	ns
$t_F$	Fall Time	-	-	40	ns

**Figure 12-3 : 4-wire Serial interface characteristics**

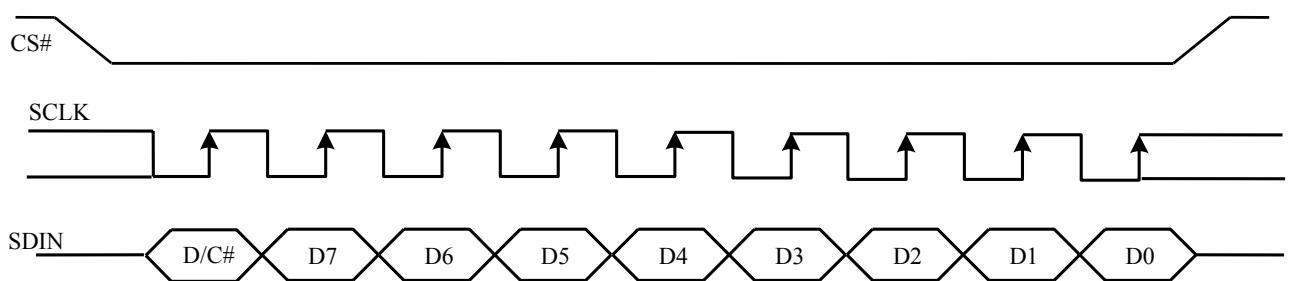
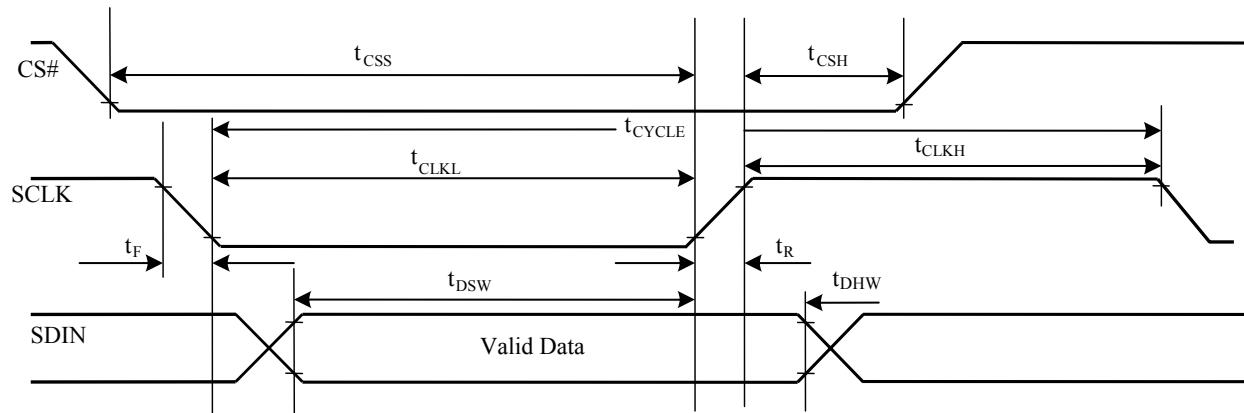


**Table 12-5 : 3-wire Serial Interface Timing Characteristics**

( $V_{DD} - V_{SS} = 1.65V$  to  $3.3V$ ,  $T_A = 25^\circ C$ )

Symbol	Parameter	Min	Typ	Max	Unit
$t_{cycle}$	Clock Cycle Time	100	-	-	ns
$t_{CSS}$	Chip Select Setup Time	20	-	-	ns
$t_{CSH}$	Chip Select Hold Time	10	-	-	ns
$t_{DSW}$	Write Data Setup Time	15	-	-	ns
$t_{DHW}$	Write Data Hold Time	15	-	-	ns
$t_{CLKL}$	Clock Low Time	20	-	-	ns
$t_{CLKH}$	Clock High Time	20	-	-	ns
$t_R$	Rise Time	-	-	40	ns
$t_F$	Fall Time	-	-	40	ns

**Figure 12-4 : 3-wire Serial interface characteristics**



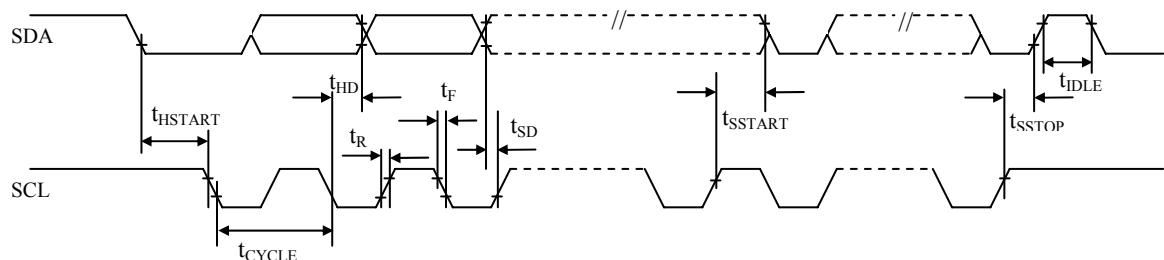
**Conditions:**

$V_{DD} - V_{SS} = V_{DD} - V_{SS} = 1.65V$  to  $3.3V$   
 $T_A = 25^\circ C$

**Table 12-6 : I<sup>2</sup>C Interface Timing Characteristics**

Symbol	Parameter	Min	Typ	Max	Unit
$t_{cycle}$	Clock Cycle Time	2.5	-	-	us
$t_{HSTART}$	Start condition Hold Time	0.6	-	-	us
$t_{HD}$	Data Hold Time (for "SDA <sub>OUT</sub> " pin)	0	-	-	ns
	Data Hold Time (for "SDA <sub>IN</sub> " pin)	300	-	-	ns
$t_{SD}$	Data Setup Time	100	-	-	ns
$t_{SSTART}$	Start condition Setup Time (Only relevant for a repeated Start condition)	0.6	-	-	us
$t_{SSTOP}$	Stop condition Setup Time	0.6	-	-	us
$t_R$	Rise Time for data and clock pin	-	-	300	ns
$t_F$	Fall Time for data and clock pin	-	-	300	ns
$t_{IDLE}$	Idle Time before a new transmission can start	1.3	-	-	us

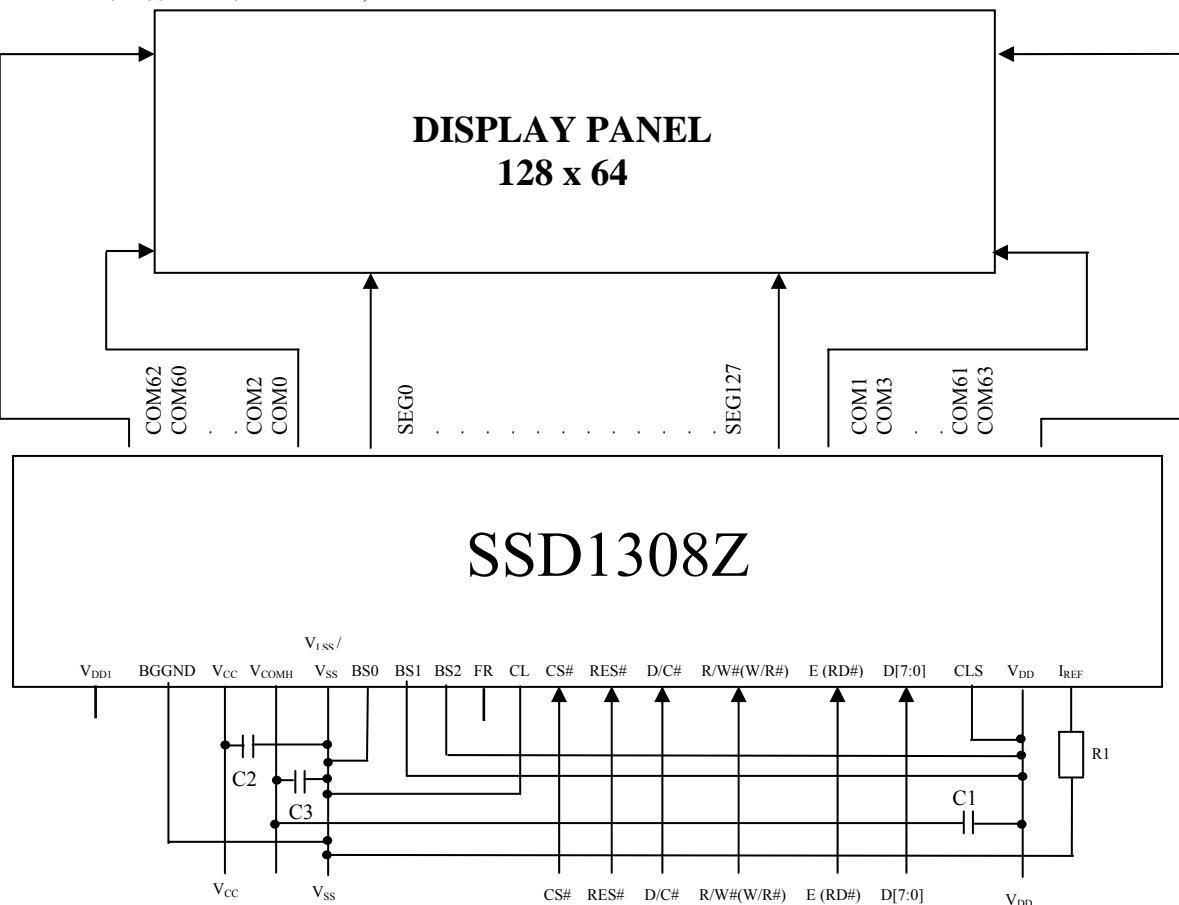
**Figure 12-5 : I<sup>2</sup>C interface Timing characteristics**



## 13 Application Example

Figure 13-1 : Application Example of SSD1308Z with External I<sub>REF</sub>

The configuration for 8080-parallel interface mode and External I<sub>REF</sub> is shown in the following diagram:  
(V<sub>DD</sub>=2.8V, V<sub>CC</sub>=12V, I<sub>REF</sub>=19uA)



Pin connected to MCU interface: D[7:0], E (RD#), R/W#(W/R#) , D/C#, CS#, RES#  
V<sub>DD1</sub> , TR0-TR11, FR should be left open.

C1: 1.0uF <sup>(1)</sup>  
C2: 2.2uF <sup>(1)</sup>  
C3: 2.2uF <sup>(1)</sup>

Voltage at I<sub>REF</sub> = V<sub>CC</sub> - 2.5V. For V<sub>CC</sub> = 12V, I<sub>REF</sub> = 19uA:

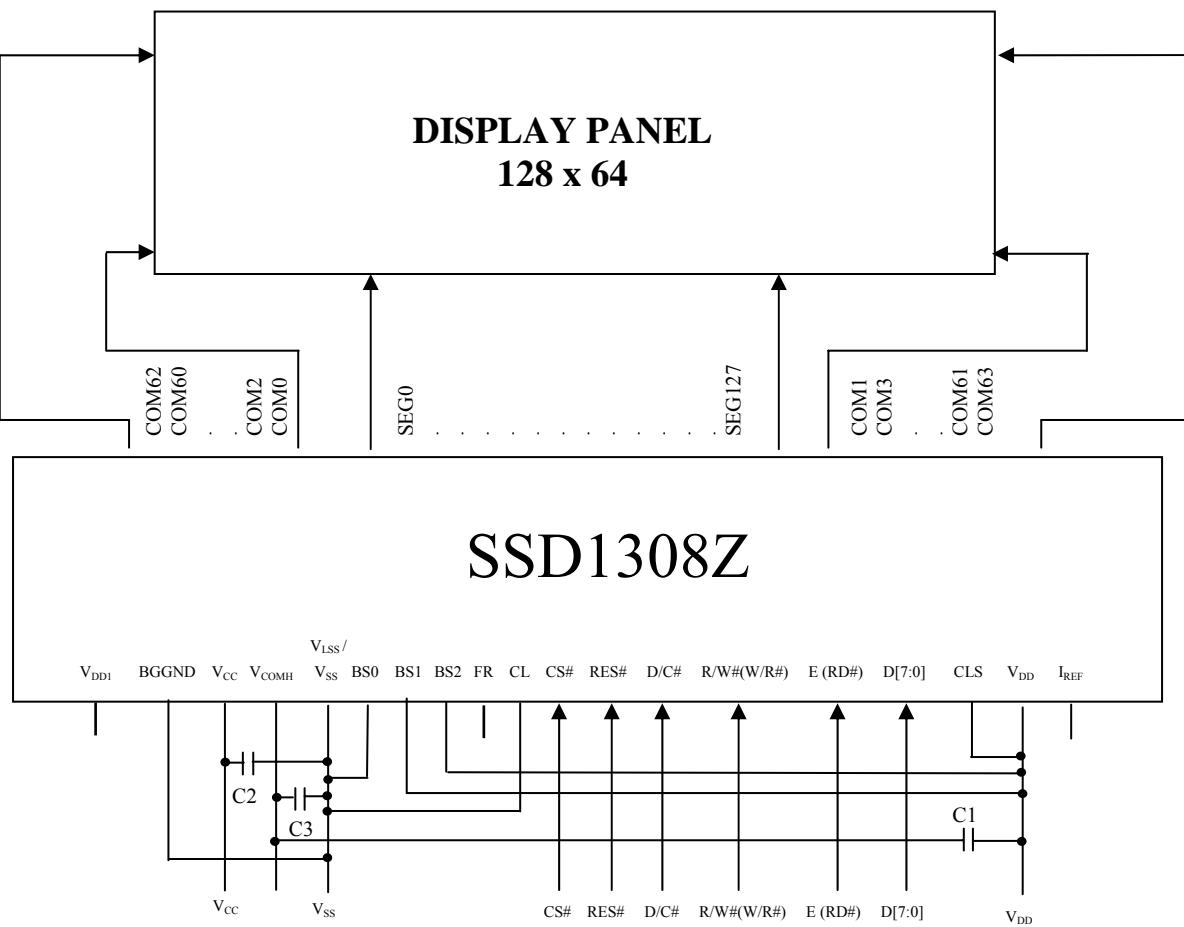
$$\begin{aligned} R1 &= (\text{Voltage at } I_{\text{REF}} - V_{\text{SS}}) / I_{\text{REF}} \\ &= (12 - 2.5) / 19 \mu\text{A} \\ &= 500 \text{K}\Omega \end{aligned}$$

### Note

<sup>(1)</sup>The capacitor value is recommended value. Select appropriate value against module application.

**Figure 13-2 : Application Example of SSD1308Z with Internal I<sub>REF</sub>**

The configuration for 8080-parallel interface mode and Internal I<sub>REF</sub> is shown in the following diagram:  
 $(V_{DD}=2.8V, V_{CC}=12V, I_{REF} \text{ is internally generated by setting command ADh.})$



Pin connected to MCU interface: D[7:0], E (RD#), R/W#(W/R#), D/C#, CS#, RES#  
 $I_{REF}$ ,  $V_{DDI}$ , TR0-TR11, FR should be left open.

C1: 1.0uF<sup>(1)</sup>  
 C2: 2.2uF<sup>(1)</sup>  
 C3: 2.2uF<sup>(1)</sup>

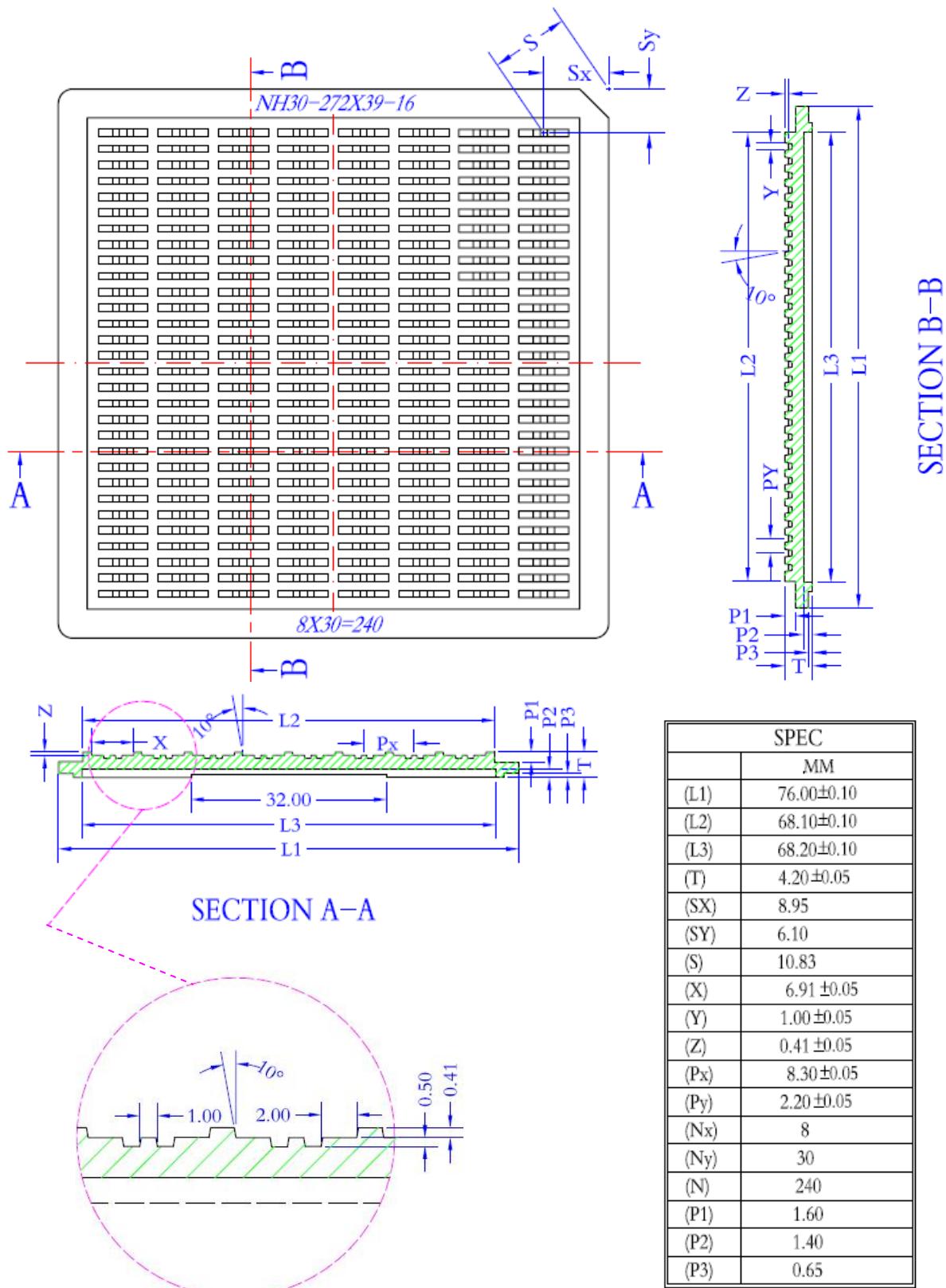
#### Note

<sup>(1)</sup>The capacitor value is recommended value. Select appropriate value against module application.

## 14 PACKAGE INFORMATION

### 14.1 SSD1308Z Die Tray Information

Figure 14-1 : SSD1308Z die tray information



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